

- **High-Performance Floating-Point DSP**
  - TMS320C32-60 (5 V)
    - 33-ns Instruction Cycle Time
    - 330 Million Operations Per Second (MOPS), 60 Million Floating-Point Operations Per Second (MFLOPS), 30 Million Instructions Per Second (MIPS)
  - TMS320C32-50 (5 V)
    - 40-ns Instruction Cycle Time
    - 275 MOPS, 50 MFLOPS, 25 MIPS
  - TMS320C32-40 (5 V)
    - 50-ns Instruction Cycle Time
    - 220 MOPS, 40 MFLOPS, 20 MIPS
- **32-Bit High-Performance CPU**
- **16-/32-Bit Integer and 32-/40-Bit Floating-Point Operations**
- **32-Bit Instruction Word, 24-Bit Addresses**
- **Two 256 × 32-Bit Single-Cycle, Dual-Access On-Chip RAM Blocks**
- **Flexible Boot-Program Loader**
- **On-Chip Memory-Mapped Peripherals:**
  - One Serial Port
  - Two 32-Bit Timers
  - Two-Channel Direct Memory Access (DMA) Coprocessor With Configurable Priorities
- **Enhanced External Memory Interface That Supports 8-/16-/32-Bit-Wide External RAM for Data Access and Program Execution From 16-/32-Bit-Wide External RAM**
- **TMS320C30 and TMS320C31 Object Code Compatible**
- **Fabricated using 0.7 μm Enhanced Performance Implanted CMOS (EPIC™) Technology by Texas Instruments (TI™)**
- **144-Pin Plastic Quad Flat Package (PCM Suffix) 5 V**
- **Eight Extended-Precision Registers**
- **Two Address Generators With Eight Auxiliary Registers and Two Auxiliary Register Arithmetic Units (ARAUs)**
- **Two Low-Power Modes**
- **Two- and Three-Operand Instructions**
- **Parallel Arithmetic Logic Unit (ALU) and Multiplier Execution in a Single Cycle**
- **Block-Repeat Capability**
- **Zero-Overhead Loops With Single-Cycle Branches**
- **Conditional Calls and Returns**
- **Interlocked Instructions for Multiprocessing Support**
- **One External Pin, PRGW, That Configures the External-Program-Memory Width to 16 or 32 Bits**
- **Two Sets of Memory Strokes ( $\overline{\text{STRB0}}$  and  $\overline{\text{STRB1}}$ ) and One I/O Strobe ( $\overline{\text{IOSTRB}}$ ) Allow Zero-Glue Logic Interface to Two Banks of Memory and One Bank of External Peripherals**
- **Separate Bus-Control Registers for Each Strobe-Control Wait-State Generation, External Memory Width, and Data Type Size**
- **$\overline{\text{STRB0}}$  and  $\overline{\text{STRB1}}$  Memory Strokes Handle 8-, 16-, or 32-Bit External Data Accesses (Reads and Writes)**
- **Multiprocessor Support Through the  $\overline{\text{HOLD}}$  and  $\overline{\text{HOLDA}}$  Signals Is Valid for All Strokes**

## description

The TMS320C32 is the newest member of the TMS320C3x generation of digital signal processors (DSPs) from Texas Instruments. The TMS320C32 is an enhanced 32-bit floating-point processor manufactured in 0.7-μm triple-level-metal CMOS technology. The enhancements to the TMS320C3x architecture include a variable-width external-memory interface, faster instruction cycle time, power-down modes, two-channel DMA coprocessor with configurable priorities, flexible boot loader, relocatable interrupt-vector table, and edge- or level-triggered interrupts.



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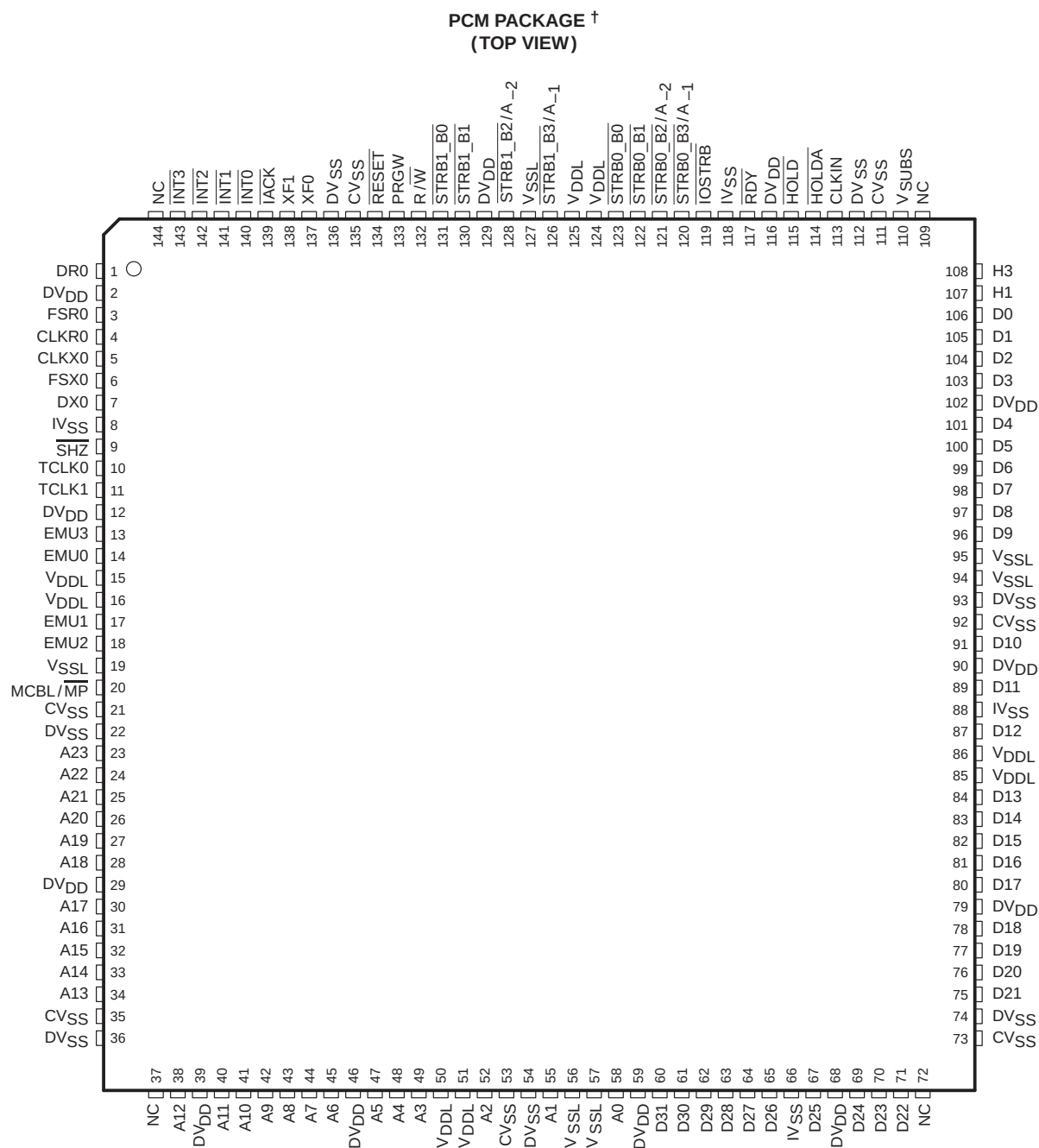
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# TMS320C32 DIGITAL SIGNAL PROCESSOR

SPRS027C – JANUARY 1995 – REVISED DECEMBER 1996

## pin assignments



### Pin Assignments

| PIN<br>NUMBER | NAME             | PIN<br>NUMBER | NAME             | PIN<br>NUMBER | NAME             | PIN<br>NUMBER | NAME              | PIN<br>NUMBER | NAME               |
|---------------|------------------|---------------|------------------|---------------|------------------|---------------|-------------------|---------------|--------------------|
| 1             | DR0              | 30            | A17              | 59            | DV <sub>DD</sub> | 88            | IV <sub>SS</sub>  | 117           | RDY                |
| 2             | DV <sub>DD</sub> | 31            | A16              | 60            | D31              | 89            | D11               | 118           | IV <sub>SS</sub>   |
| 3             | FSR0             | 32            | A15              | 61            | D30              | 90            | DV <sub>DD</sub>  | 119           | I <sub>OSTRB</sub> |
| 4             | CLKR0            | 33            | A14              | 62            | D29              | 91            | D10               | 120           | STRB0_B3/A_1       |
| 5             | CLKX0            | 34            | A13              | 63            | D28              | 92            | CV <sub>SS</sub>  | 121           | STRB0_B2/A_2       |
| 6             | FSX0             | 35            | CV <sub>SS</sub> | 64            | D27              | 93            | DV <sub>SS</sub>  | 122           | STRB0_B1           |
| 7             | DX0              | 36            | DV <sub>SS</sub> | 65            | D26              | 94            | V <sub>SSL</sub>  | 123           | STRB0_B0           |
| 8             | IV <sub>SS</sub> | 37            | NC               | 66            | IV <sub>SS</sub> | 95            | V <sub>SSL</sub>  | 124           | V <sub>DDL</sub>   |
| 9             | SHZ              | 38            | A12              | 67            | D25              | 96            | D9                | 125           | V <sub>DDL</sub>   |
| 10            | TCLK0            | 39            | DV <sub>DD</sub> | 68            | DV <sub>DD</sub> | 97            | D8                | 126           | STRB1_B3/A_1       |
| 11            | TCLK1            | 40            | A11              | 69            | D24              | 98            | D7                | 127           | V <sub>SSL</sub>   |
| 12            | DV <sub>DD</sub> | 41            | A10              | 70            | D23              | 99            | D6                | 128           | STRB1_B2/A_2       |
| 13            | EMU3             | 42            | A9               | 71            | D22              | 100           | D5                | 129           | DV <sub>DD</sub>   |
| 14            | EMU0             | 43            | A8               | 72            | NC               | 101           | D4                | 130           | STRB1_B1           |
| 15            | V <sub>DDL</sub> | 44            | A7               | 73            | CV <sub>SS</sub> | 102           | DV <sub>DD</sub>  | 131           | STRB1_B0           |
| 16            | V <sub>DDL</sub> | 45            | A6               | 74            | DV <sub>SS</sub> | 103           | D3                | 132           | R/W                |
| 17            | EMU1             | 46            | DV <sub>DD</sub> | 75            | D21              | 104           | D2                | 133           | PRGW               |
| 18            | EMU2             | 47            | A5               | 76            | D20              | 105           | D1                | 134           | RESET              |
| 19            | V <sub>SSL</sub> | 48            | A4               | 77            | D19              | 106           | D0                | 135           | CV <sub>SS</sub>   |
| 20            | MCBL/MP          | 49            | A3               | 78            | D18              | 107           | H1                | 136           | DV <sub>SS</sub>   |
| 21            | CV <sub>SS</sub> | 50            | V <sub>DDL</sub> | 79            | DV <sub>DD</sub> | 108           | H3                | 137           | XF0                |
| 22            | DV <sub>SS</sub> | 51            | V <sub>DDL</sub> | 80            | D17              | 109           | NC                | 138           | XF1                |
| 23            | A23              | 52            | A2               | 81            | D16              | 110           | V <sub>SUBS</sub> | 139           | IACK               |
| 24            | A22              | 53            | CV <sub>SS</sub> | 82            | D15              | 111           | CV <sub>SS</sub>  | 140           | INT0               |
| 25            | A21              | 54            | DV <sub>SS</sub> | 83            | D14              | 112           | DV <sub>SS</sub>  | 141           | INT1               |
| 26            | A20              | 55            | A1               | 84            | D13              | 113           | CLKIN             | 142           | INT2               |
| 27            | A19              | 56            | V <sub>SSL</sub> | 85            | V <sub>DDL</sub> | 114           | HOLDA             | 143           | INT3               |
| 28            | A18              | 57            | V <sub>SSL</sub> | 86            | V <sub>DDL</sub> | 115           | HOLD              | 144           | NC                 |
| 29            | DV <sub>DD</sub> | 58            | A0               | 87            | D12              | 116           | DV <sub>DD</sub>  |               |                    |

# TMS320C32

## DIGITAL SIGNAL PROCESSOR

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### pin functions

This section provides signal descriptions for the TMS320C32 device. The following table lists each signal, the number of pins, operating modes, and a brief signal description. The following table groups the signals according to their function.

**TMS320C32 Pin Functions**

| PIN<br>NAME NO.                         |    | TYPE† | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | CONDITIONS<br>WHEN<br>SIGNAL IS<br>IN HIGH Z‡ |
|-----------------------------------------|----|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------|
| <b>EXTERNAL-BUS INTERFACE (70 PINS)</b> |    |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |                                               |
| A23–A0                                  | 24 | O/Z   | 24-bit address port of the external-bus interface                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | S H R                                         |
| D31–D0                                  | 32 | I/O/Z | 32-bit data port of the external-bus interface                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | S H R                                         |
| R/ $\overline{W}$                       | 1  | O/Z   | Read/write for external-memory interface. R/ $\overline{W}$ is high when a read is performed and low when a write is performed over the parallel interface.                                                                                                                                                                                                                                                                                                                                                           | S H                                           |
| $\overline{IOSTRB}$                     | 1  | O/Z   | External-peripheral I/O strobe for the external-memory interface                                                                                                                                                                                                                                                                                                                                                                                                                                                      | S H                                           |
| $\overline{STRB0\_B3/A\_1}$             | 1  | O/Z   | External-memory access strobe 0, byte enable 3 for 32-bit external-memory interface, and address pin for 8-bit and 16-bit external-memory interface                                                                                                                                                                                                                                                                                                                                                                   | S H                                           |
| $\overline{STRB0\_B2/A\_2}$             | 1  | O/Z   | External-memory access strobe 0, byte enable 2 for 32-bit external-memory interface, and address pin for 8-bit external-memory interface                                                                                                                                                                                                                                                                                                                                                                              | S H                                           |
| $\overline{STRB0\_B1}$                  | 1  | O/Z   | External-memory access strobe 0, byte enable 1 for the external-memory interface                                                                                                                                                                                                                                                                                                                                                                                                                                      | S H                                           |
| $\overline{STRB0\_B0}$                  | 1  | O/Z   | External-memory access strobe 0, byte enable 0 for the external-memory interface                                                                                                                                                                                                                                                                                                                                                                                                                                      | S H                                           |
| $\overline{STRB1\_B3/A\_1}$             | 1  | O/Z   | External-memory access strobe 1, byte enable 3 for 32-bit external-memory interface, and address pin for 8-bit and 16-bit external-memory interface                                                                                                                                                                                                                                                                                                                                                                   | S H                                           |
| $\overline{STRB1\_B2/A\_2}$             | 1  | O/Z   | External-memory access strobe 1, byte enable 2 for 32-bit external-memory interface, and address pin for 8-bit external-memory interface                                                                                                                                                                                                                                                                                                                                                                              | S H                                           |
| $\overline{STRB1\_B1}$                  | 1  | O/Z   | External-memory access strobe 1, byte enable 1 for the external-memory interface                                                                                                                                                                                                                                                                                                                                                                                                                                      | S H                                           |
| $\overline{STRB1\_B0}$                  | 1  | O/Z   | External-memory access strobe 1, byte enable 0 for the external-memory interface                                                                                                                                                                                                                                                                                                                                                                                                                                      | S H                                           |
| $\overline{RDY}$                        | 1  | I     | Ready. $\overline{RDY}$ indicates that the external device is prepared for an external-memory interface transaction to complete.                                                                                                                                                                                                                                                                                                                                                                                      |                                               |
| $\overline{HOLD}$                       | 1  | I     | Hold signal for external-memory interface. When $\overline{HOLD}$ is a logic low, any ongoing transaction is completed. A23–A0, D31–D0, $\overline{IOSTRB}$ , $\overline{STRB0\_Bx}$ , $\overline{STRB1\_Bx}$ , and R/ $\overline{W}$ are placed in the high-impedance state, and all transactions over the external-memory interface are held until $\overline{HOLD}$ becomes a logic high or the NOHOLD bit of the STRB0 bus-control register is set.                                                               |                                               |
| $\overline{HOLDA}$                      | 1  | O/Z   | Hold acknowledge for external-memory interface. $\overline{HOLDA}$ is generated in response to a logic low on $\overline{HOLD}$ . $\overline{HOLDA}$ indicates that A23–A0, D31–D0, $\overline{IOSTRB}$ , $\overline{STRB0\_Bx}$ , $\overline{STRB1\_Bx}$ , and R/ $\overline{W}$ are in the high-impedance state and that all transactions over the memory are held. $\overline{HOLDA}$ is high in response to a logic high of $\overline{HOLD}$ or when the NOHOLD bit of the external bus-control register is set. | S                                             |
| PRGW                                    | 1  | I     | Program memory width select. When PRGW is a logic low, program is fetched as a single 32-bit word. When PRGW is a logic high, two 16-bit program fetches are performed to fetch a single 32-bit instruction word. The status of PRGW at device reset affects the reset value of the STRB0 and STRB1 bus-control register.                                                                                                                                                                                             |                                               |
| A23–A0                                  | 24 | O/Z   | 24-bit address port of the external-bus interface                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | S H R                                         |

† I = input, O = output, Z = high-impedance state

‡ S = SHZ active, H = HOLD active, R = RESET active



**TMS320C32 Pin Functions (Continued)**

| PIN<br>NAME<br>NO.                                      |   | TYPE <sup>†</sup> | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                         | CONDITIONS<br>WHEN<br>SIGNAL IS<br>IN HIGH Z <sup>‡</sup> |   |
|---------------------------------------------------------|---|-------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------|---|
| CONTROL SIGNALS (9 PINS)                                |   |                   |                                                                                                                                                                                                                                                                                                                                                                                                                                                     |                                                           |   |
| $\overline{\text{RESET}}$                               | 1 | I                 | Reset. When $\overline{\text{RESET}}$ is a logic low, the device is in the reset condition. When $\overline{\text{RESET}}$ becomes a logic high, execution begins from the location specified by the reset vector.                                                                                                                                                                                                                                  |                                                           |   |
| $\overline{\text{INT3}}\text{--}\overline{\text{INT0}}$ | 4 | I                 | External interrupts                                                                                                                                                                                                                                                                                                                                                                                                                                 |                                                           |   |
| $\overline{\text{IACK}}$                                | 1 | O/Z               | Interrupt acknowledge. $\overline{\text{IACK}}$ is generated by the IACK instruction. This signal can be used to indicate the beginning or end of an interrupt-service routine.                                                                                                                                                                                                                                                                     | S                                                         |   |
| $\overline{\text{MCBL}}/\overline{\text{MP}}$           | 1 | I                 | Microcomputer boot loader/microprocessor mode                                                                                                                                                                                                                                                                                                                                                                                                       |                                                           |   |
| $\text{XF1--XF0}$                                       | 2 | I/O/Z             | External flags. XF1 and XF0 are used as general-purpose I/Os or used to support interlocked-processor instructions.                                                                                                                                                                                                                                                                                                                                 | S                                                         | R |
| SERIAL PORT SIGNALS (6 PINS)                            |   |                   |                                                                                                                                                                                                                                                                                                                                                                                                                                                     |                                                           |   |
| CLKX0                                                   | 1 | I/O/Z             | Serial-port 0 transmit clock. CLKX0 is the serial shift clock for the serial port 0 transmitter.                                                                                                                                                                                                                                                                                                                                                    | S                                                         | R |
| DX0                                                     | 1 | I/O/Z             | Data-transmit output. Serial port 0 transmits serial data on DX0.                                                                                                                                                                                                                                                                                                                                                                                   | S                                                         | R |
| FSX0                                                    | 1 | I/O/Z             | Frame-synchronization pulse for transmit. The FSX0 pulse initiates the transmit-data process over DX0.                                                                                                                                                                                                                                                                                                                                              | S                                                         | R |
| CLKR0                                                   | 1 | I/O/Z             | Serial-port 0 receive clock. CLKR0 is the serial-shift clock for the serial-port 0 receiver.                                                                                                                                                                                                                                                                                                                                                        | S                                                         | R |
| DR0                                                     | 1 | I/O/Z             | Data receive. Serial port 0 receives serial data on DR0.                                                                                                                                                                                                                                                                                                                                                                                            | S                                                         | R |
| FSR0                                                    | 1 | I/O/Z             | Frame-synchronization pulse for receive. The FSR0 pulse initiates the receive-data process over DR0.                                                                                                                                                                                                                                                                                                                                                | S                                                         | R |
| TIMER SIGNALS (2 PINS)                                  |   |                   |                                                                                                                                                                                                                                                                                                                                                                                                                                                     |                                                           |   |
| TCLK0                                                   | 1 | I/O/Z             | Timer clock 0. As an input, TCLK0 is used by timer 0 to count external pulses. As an output, TCLK0 outputs pulses generated by timer 0.                                                                                                                                                                                                                                                                                                             | S                                                         | R |
| TCLK1                                                   | 1 | I/O/Z             | Timer clock 1. As an input, TCLK1 is used by timer 1 to count external pulses. As an output, TCLK1 outputs pulses generated by timer 1.                                                                                                                                                                                                                                                                                                             | S                                                         | R |
| CLOCK SIGNALS (3 PINS)                                  |   |                   |                                                                                                                                                                                                                                                                                                                                                                                                                                                     |                                                           |   |
| CLKIN                                                   | 1 | I                 | Input to the internal oscillator from an external clock source                                                                                                                                                                                                                                                                                                                                                                                      |                                                           |   |
| H1                                                      | 1 | O/Z               | External H1 clock. H1 has a period equal to twice CLKIN.                                                                                                                                                                                                                                                                                                                                                                                            | S                                                         |   |
| H3                                                      | 1 | O/Z               | External H3 clock. H3 has a period equal to twice CLKIN.                                                                                                                                                                                                                                                                                                                                                                                            | S                                                         |   |
| RESERVED (5 PINS)                                       |   |                   |                                                                                                                                                                                                                                                                                                                                                                                                                                                     |                                                           |   |
| EMU0–EMU2                                               | 3 | I                 | Reserved for emulation. Use 18 k $\Omega$ –22 k $\Omega$ pullup resistors to 5 V.                                                                                                                                                                                                                                                                                                                                                                   |                                                           |   |
| EMU3                                                    | 1 | O/Z               | Reserved for emulation                                                                                                                                                                                                                                                                                                                                                                                                                              | S                                                         |   |
| $\overline{\text{SHZ}}$                                 | 1 | I                 | Shutdown high impedance. When active, $\overline{\text{SHZ}}$ shuts down the 'C32 and places all 3-state I/O pins in the high-impedance state. $\overline{\text{SHZ}}$ is used for board-level testing to ensure that no dual-drive conditions occur. <b>CAUTION:</b> A low on $\overline{\text{SHZ}}$ corrupts 'C32 memory and register contents. Reset the device with $\overline{\text{SHZ}}$ high to restore it to a known operating condition. |                                                           |   |

† I = input, O = output, Z = high-impedance state

‡ S =  $\overline{\text{SHZ}}$  active, H = HOLD active, R =  $\overline{\text{RESET}}$  active

# TMS320C32

## DIGITAL SIGNAL PROCESSOR

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**TMS320C32 Pin Functions (Continued)**

| PIN<br>NAME NO.     |    | TYPE† | DESCRIPTION              | CONDITIONS<br>WHEN<br>SIGNAL IS<br>IN HIGH Z‡ |
|---------------------|----|-------|--------------------------|-----------------------------------------------|
| <b>POWER/GROUND</b> |    |       |                          |                                               |
| CVSS                | 7  | I     | Ground                   |                                               |
| DVSS                | 7  | I     | Ground                   |                                               |
| IVSS                | 4  | I     | Ground                   |                                               |
| DVDD                | 12 | I     | + 5-V dc supply§         |                                               |
| VDDL                | 8  | I     | + 5-V dc supply§         |                                               |
| VSSL                | 6  | I     | Ground                   |                                               |
| VSUBS               | 1  | I     | Substrate, tie to ground |                                               |

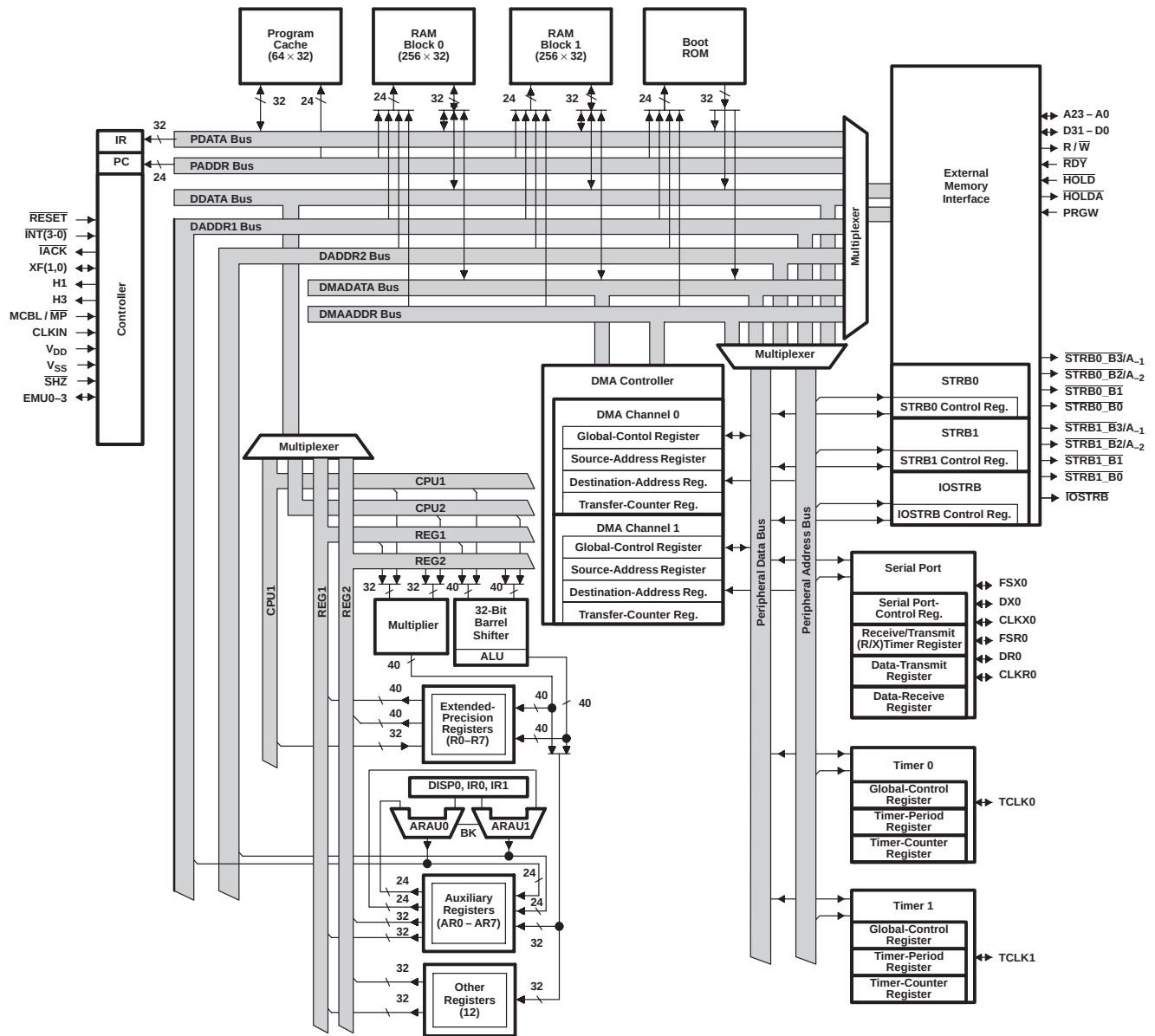
† I = input, O = output, Z = high-impedance state

‡ S = SHZ active, H = HOLD active, R = RESET active

§ Recommended decoupling capacitor is 0.1  $\mu$ F.



## functional block diagram



## operation

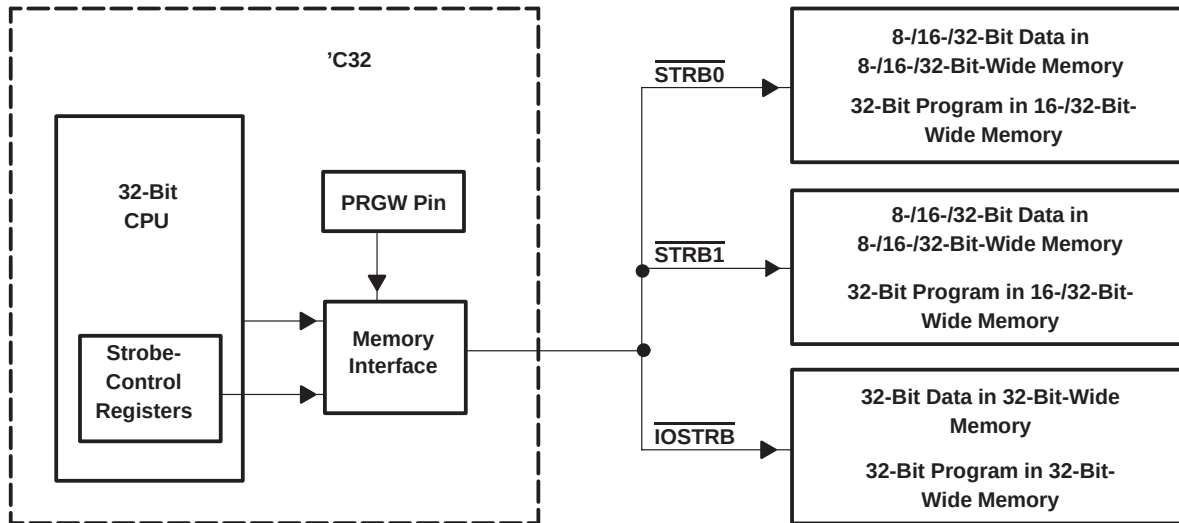
Operation of the TMS320C32 is identical to the TMS320C30 and TMS320C31 digital signal processors, with the exception of an enhanced external memory interface and the addition of two CPU power-management modes.

## external-memory interface

The TMS320C32 has a configurable external-memory interface with a 24-bit address bus, a 32-bit data bus, and three independent multifunction strobes. The flexibility of this unique interface enables product designers to minimize external-memory chip count.

### external memory interface (continued)

Up to three mutually exclusive memory areas (one program area and two data areas) can be implemented. Each memory area configuration is independent of the physical memory width and independent of the configuration of other memory areas. See Figure 1.



**Figure 1. 'C32 External Memory Interface**

The TMS320C32's external-memory configuration is controlled by a combination of hardware configuration and memory-mapped control registers and can be reconfigured dynamically. The signals that control external-memory configuration are the PRGW,  $\overline{\text{STRB0}}$ ,  $\overline{\text{STRB1}}$ , and  $\overline{\text{IOSTRB}}$ . The signals work as follows:

- The TMS320C32 is a 32-bit microprocessor, that is, the CPU operates on 32-bit program words. The external-memory interface provides the capability of fetching instructions as either 32-bit words or two 16-bit half words from consecutive addresses. Program memory width is 16 bits if the PRGW signal is high, 32 bits if the PRGW signal is low.
- $\overline{\text{STRB0}}$  and  $\overline{\text{STRB1}}$  are sets of control signals, four signals each, that are mapped to specific ranges of external-memory addresses. When an address within one of these ranges is accessed by a read or write instruction (CPU or DMA), the corresponding set of control signals is activated. Figure 8 illustrates the TMS320C32 memory map, showing the address ranges for which the strobe signals become active.

The behavior of the  $\overline{\text{STRB0}}$  and  $\overline{\text{STRB1}}$  control signals is determined by the contents of the  $\overline{\text{STRB0}}$  and  $\overline{\text{STRB1}}$  control registers.

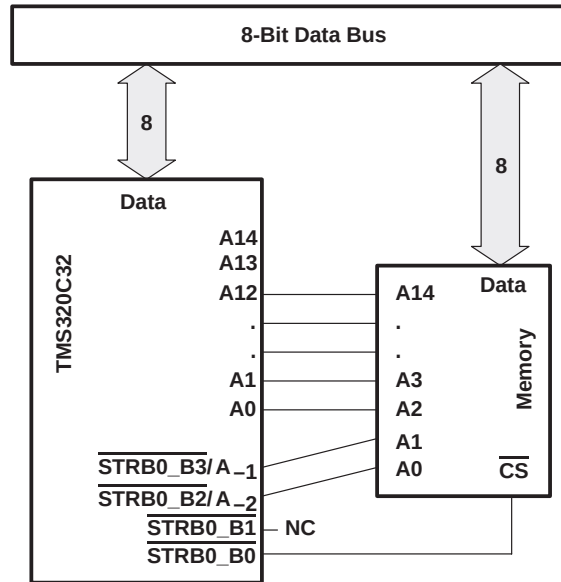
The  $\overline{\text{STRB0}}$  and  $\overline{\text{STRB1}}$  control registers each have a field that specifies the physical memory width (8, 16, or 32 bits) of the external-memory address ranges they control. Another field specifies the data width (8, 16, or 32 bits) of the data contained in those addresses. The values in these fields are not required to match. For example, a 32-bit-wide physical memory space can be configured to segment each 32-bit word into four consecutive 8-bit locations, each having its own address.

Each control-signal set has two pins ( $\overline{\text{STRBx\_B2/A\_2}}$  and  $\overline{\text{STRBx\_B3/A\_1}}$ ) that can act as either byte-enable (chip-select) pins or address pins, and two dedicated byte-enable (chip-select) pins ( $\overline{\text{STRBx\_B0}}$  and  $\overline{\text{STRBx\_B1}}$ ). The pin functions are determined by the physical memory width specified in the corresponding control register.



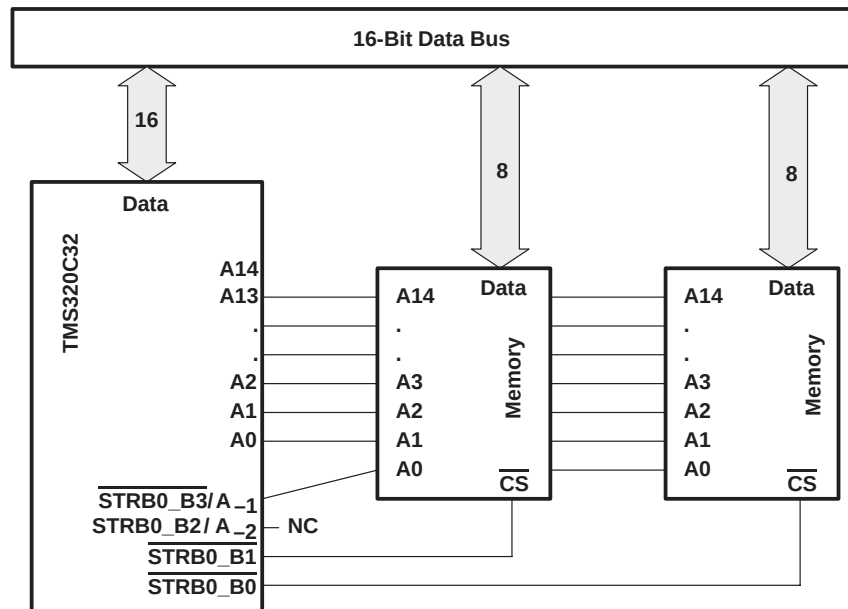
**external memory interface (continued)**

- For 8-bit-wide physical memory, the  $\overline{\text{STRBx\_B2/A\_2}}$  and  $\overline{\text{STRBx\_B3/A\_1}}$  pins function as address pins (least significant address bits) and the  $\overline{\text{STRBx\_B0}}$  pin functions as a byte-enable (chip-select) pin.  $\overline{\text{STRBx\_B1}}$  is unused. See Figure 2.



**Figure 2. 'C32 With 8-Bit-Wide External Memory**

- For 16-bit-wide physical memory, the  $\overline{\text{STRBx\_B3/A\_1}}$  pin functions as an address pin (least significant address bits). The  $\overline{\text{STRBx\_B0}}$  and  $\overline{\text{STRBx\_B1}}$  pins function as byte-enable (chip-select) pins.  $\overline{\text{STRBx\_B2/A\_2}}$  is unused. See Figure 3.



**Figure 3. 'C32 With 16-Bit-Wide External Memory**

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## external memory interface (continued)

- For 32-bit-wide physical memory, all  $\overline{\text{STRB0}}$  and  $\overline{\text{STRB1}}$  pins function as byte-enable (chip-select) pins. See Figure 4.

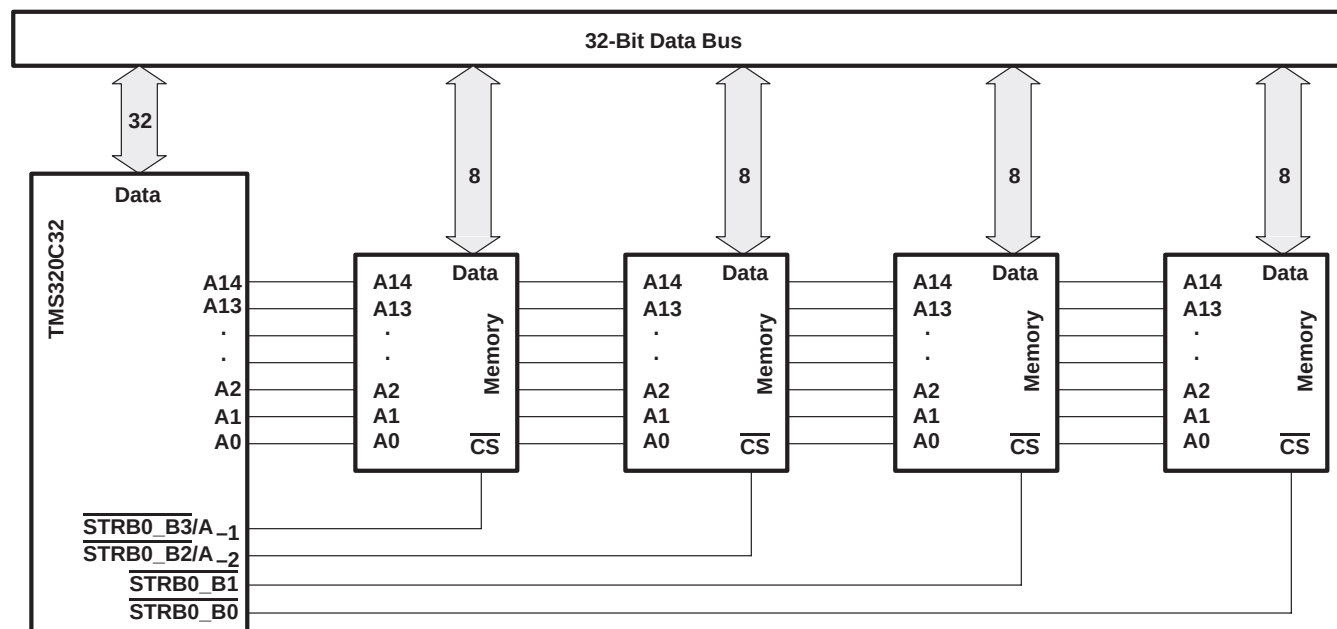


Figure 4. 'C32 With 32-Bit-Wide External Memory

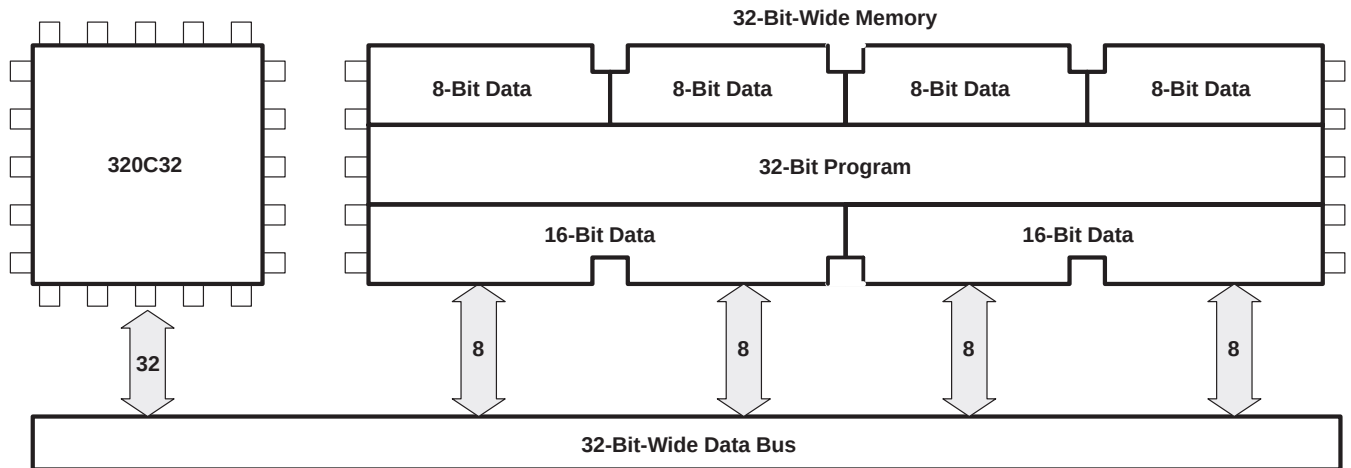
For more detailed information and examples see *TMS320C32 Addendum to the TMS320C3x User's Guide* (literature number SPRU132) and *Interfacing Memory to the TMS320C32 DSP Application Report* (literature number SPRA040).

- The  $\overline{\text{IOSTRB}}$  control signal, like  $\overline{\text{STRB0}}$  and  $\overline{\text{STRB1}}$ , also is mapped to a specific range of addresses but it is a single signal that can access only 32-bit data from 32-bit-wide memory. Its range of addresses appears in the TMS320C32 memory map, shown in Figure 8. The  $\overline{\text{IOSTRB}}$  bus timing is different from the  $\overline{\text{STRB0}}$  and  $\overline{\text{STRB1}}$  bus timings to accommodate slower I/O peripherals.

## external memory interface (continued)

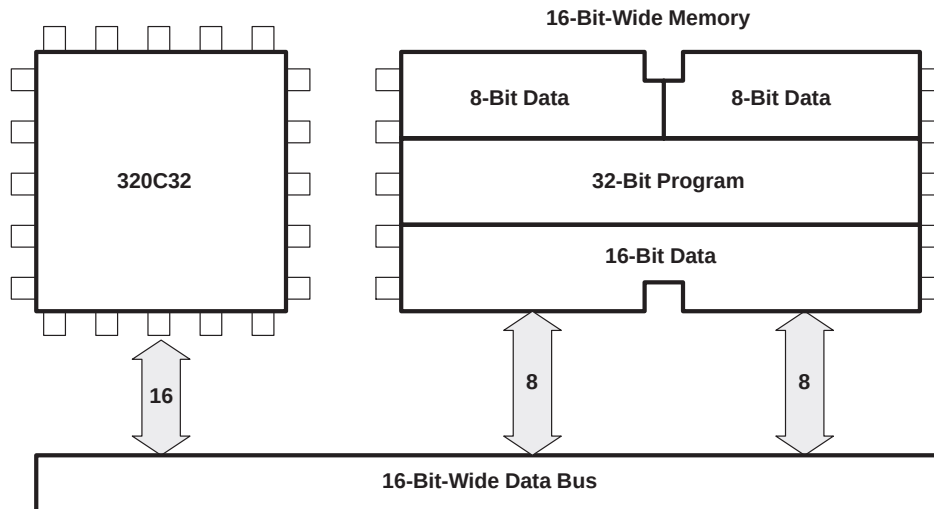
### examples

Figure 5 and Figure 6 show examples of external memory configurations that can be implemented using the TMS320C32 external memory interface. The first example has a 32-bit-wide external memory with 8- and 16-bit data areas and a 32-bit program area.



**Figure 5. 32-Bit-Wide External Memory Configured With 8- and 16-Bit Data Areas and 32-Bit Program Memory**

Figure 6 shows a configuration that can be implemented with 16-bit external memory. The 32-bit data and program words can be stored and retrieved as half-words.



**Figure 6. 16-Bit-Wide External Memory Configured With 8- and 16-Bit Data Areas and a 32-Bit Program Area**

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### external memory interface (continued)

Figure 7 shows one possible configuration that can be implemented with 8-bit external memory. Program words, which are 32-bit, cannot be executed from 8-bit-wide memory.

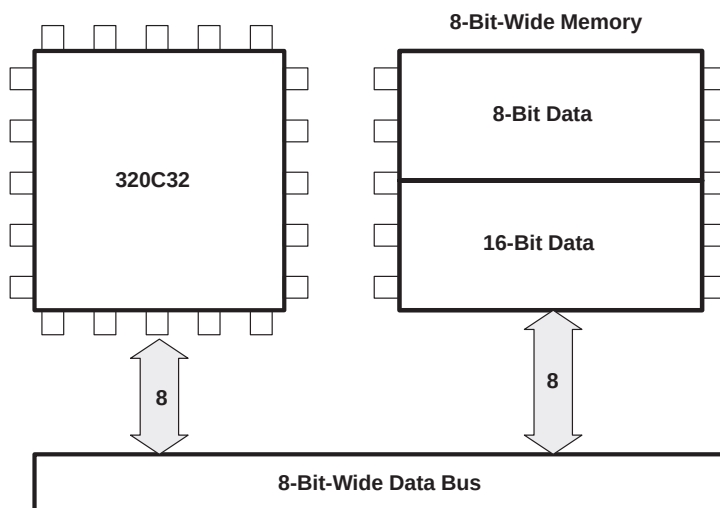
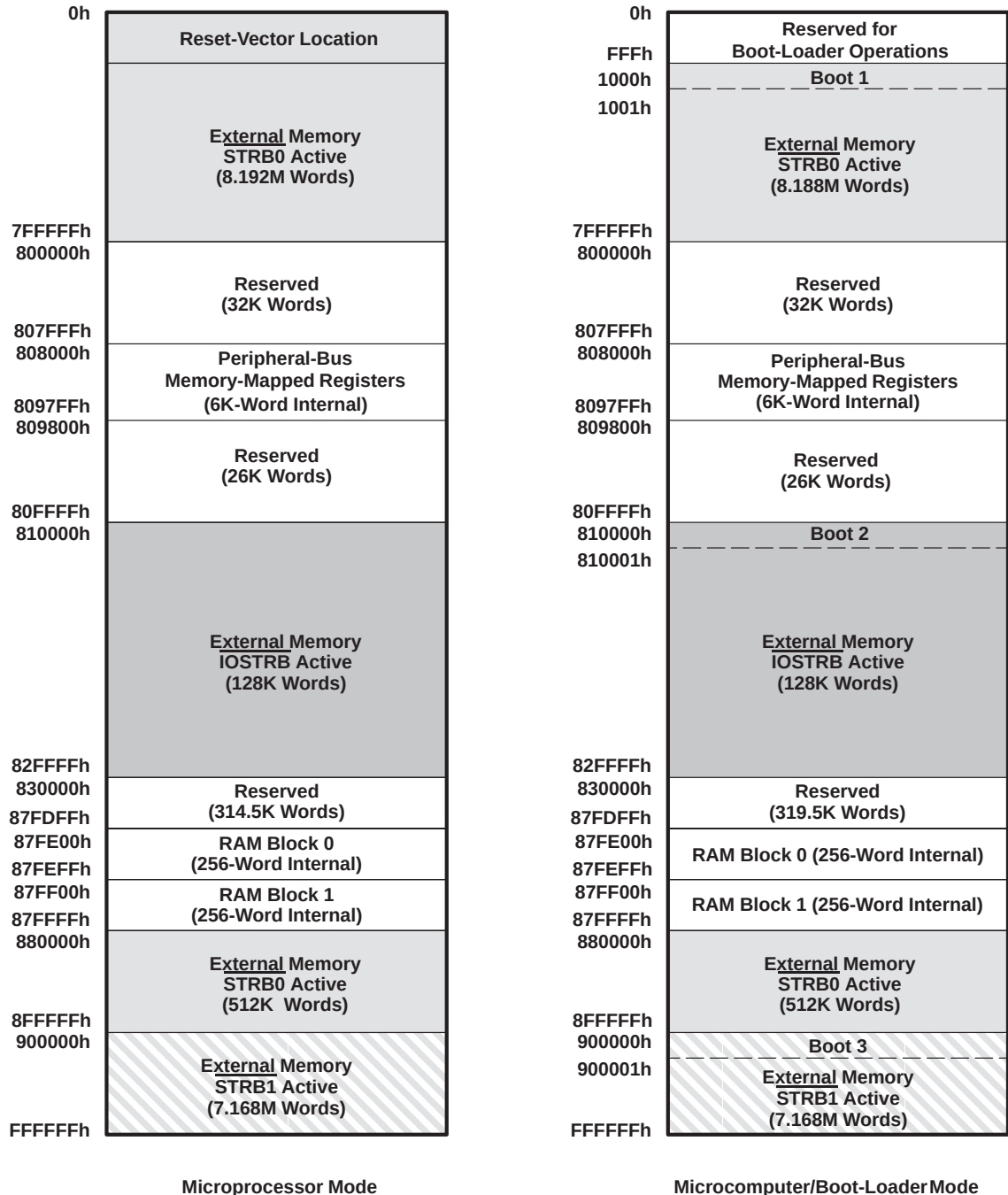


Figure 7. 8-Bit-Wide External Memory Configured With 8- and 16-Bit Data Areas

## memory map

Figure 8 depicts the memory map for the TMS320C32. Refer to the TMS320C32 Addendum to the *TMS320C3x User's Guide* (literature number SPRU132) for a detailed description of this memory mapping, with shading to indicate external memory.



**Figure 8. TMS320C32 Memory Map**

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### power management

The TMS320C32 CPU has two power-management modes, IDLE2 and LOPOWER (low power). In IDLE2 mode, no instructions are executed and the CPU, peripherals, and memory retain their previous state while the external bus output pins are idle. During IDLE2 mode, the H1 clock signal is held high while the H3 clock signal is held low until one of the four external interrupts is asserted. In the LOPOWER mode, the CPU continues to execute instructions and the DMA continues to perform transfers, but at a reduced clock rate of the CLKIN frequency divided by 16 (that is, TMS320C32 with a 32-MHz CLKIN frequency performs the same as a 2-MHz TMS320C32 with an instruction cycle time of 1000 ns (1 MHz).

### boot loader

The TMS320C32 flexible boot loader loads programs from the serial port, EPROM, or other standard non-volatile memory device. The boot-loader functionality of the TMS320C32 is equivalent to that of the TMS320C31, and has added modes to handle the data-type sizes and memory widths supported by the external memory interface. The memory-boot load supports data transfers with and without handshaking. The handshake mode allows synchronous transfer of programs by using two pins as data-acknowledge and data-ready signals.

### peripherals

The TMS320C32 peripherals are composed of one serial port, two timers, and two DMA channels. The serial port and timers are the functional equivalent of those in the TMS320C31 peripherals. The TMS320C32 two-channel DMA coprocessor has user-configurable priorities: CPU, DMA, or rotating between CPU and DMA.



**peripherals (continued)**

Figure 9 shows the TMS320C32's peripheral-bus control-register mapping, with the reserved areas shaded.

|         |                                         |
|---------|-----------------------------------------|
| 808000h | DMA 0 Global Control                    |
| 808004h | DMA 0 Source Address                    |
| 808006h | DMA 0 Destination Address               |
| 808008h | DMA 0 Transfer Counter                  |
| 808009h |                                         |
| 808010h | DMA 1 Global Control                    |
| 808014h | DMA 1 Source Address                    |
| 808016h | DMA 1 Destination Address               |
| 808018h | DMA 1 Transfer Counter                  |
| 808020h | Timer 0 Global Control                  |
| 808024h | Timer 0 Counter                         |
| 808028h | Timer 0 Period                          |
| 808030h | Timer 1 Global Control                  |
| 808034h | Timer 1 Counter                         |
| 808038h | Timer 1 Period Register                 |
| 808040h | Serial Port Global Control              |
| 808042h | FSX/DX/CLKX Port Control                |
| 808043h | FSR/DR/CLKR Port Control                |
| 808044h | R/X Timer Control                       |
| 808045h | R/X Timer Counter                       |
| 808046h | R/X Timer Period                        |
| 808048h | Data Transmit                           |
| 80804Ch | Data Receive                            |
| 808050h | Reserved                                |
| 80805Fh |                                         |
| 808060h | $\overline{\text{IOSTRB}}$ -Bus Control |
| 808064h | $\overline{\text{STRB0}}$ -Bus Control  |
| 808068h | $\overline{\text{STRB1}}$ -Bus Control  |
| 808069h | Reserved                                |
| 8097FFh |                                         |

 Reserved

**Figure 9. Peripheral-Bus Memory-Mapped Registers**

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### interrupts

To reduce external logic and simplify the interface, the external interrupts can be either edge- or level-triggered. Unlike the fixed interrupt-trap vector-table location of the TMS320C30 and TMS320C31 devices, the TMS320C32 has a user-relocatable interrupt-trap vector table. The interrupt-trap vector table must start on a 256-word boundary. Figure 10 shows the interrupt and trap vector locations memory mapping with shading to indicate reserved areas. The reset vector is fixed to address 0h as shown in Figure 8.

|                 |          |
|-----------------|----------|
| EA (ITTP) + 00h | Reserved |
| EA (ITTP) + 01h | INT0     |
| EA (ITTP) + 02h | INT1     |
| EA (ITTP) + 03h | INT2     |
| EA (ITTP) + 04h | INT3     |
| EA (ITTP) + 05h | XINT0    |
| EA (ITTP) + 06h | RINT0    |
| EA (ITTP) + 07h | Reserved |
| EA (ITTP) + 08h | Reserved |
| EA (ITTP) + 09h | TINT0    |
| EA (ITTP) + 0Ah | TINT1    |
| EA (ITTP) + 0Bh | DINT0    |
| EA (ITTP) + 0Ch | DINT1    |
| EA (ITTP) + 0Dh | Reserved |
| EA (ITTP) + 1Fh |          |
| EA (ITTP) + 20h | TRAP0    |
|                 | .        |
|                 | .        |
|                 | .        |
| EA (ITTP) + 3Bh | TRAP27   |
| EA (ITTP) + 3Ch | TRAP28   |
| EA (ITTP) + 3Dh | TRAP29   |
| EA (ITTP) + 3Eh | TRAP30   |
| EA (ITTP) + 3Fh | TRAP31   |

Reserved

Figure 10. Reset, Interrupt, and Trap Vector/Branches Memory-Map Locations



**absolute maximum ratings over specified temperature ranges (unless otherwise noted)<sup>†</sup>**

|                                                      |                |
|------------------------------------------------------|----------------|
| Supply voltage range, $V_{CC}$ (see Note 1)          | –0.3 V to 7 V  |
| Input voltage range                                  | –0.3 V to 7 V  |
| Output voltage range, $V_O$                          | –0.3 V to 7 V  |
| Continuous power dissipation (see Note 2)            | 1.95 W         |
| Operating case temperature, $T_C$ (PCM (commercial)) | 0°C to 85°C    |
| (PCMA (extended))                                    | –40°C to 125°C |
| Storage temperature range, $T_{stg}$                 | –55°C to 150°C |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to  $V_{SS}$ .

2. This value calculated for the 'C32-40. Actual operating power is less. This value was obtained under specially produced worst-case test conditions which are not sustained during normal device operation. These conditions consist of continuous parallel writes of a checkerboard pattern to the external bus at the maximum rate possible. See normal ( $I_{DD}$ ) current specification in the electrical characteristics table and refer the *Calculation of TMS320C30 Power Dissipation Application Report* (literature number SPRU031).

**recommended operating conditions (see Note 3)<sup>‡</sup>**

|                 |                                                                                                                 |                  | MIN                | NOM <sup>‡</sup>                   | MAX  | UNIT |
|-----------------|-----------------------------------------------------------------------------------------------------------------|------------------|--------------------|------------------------------------|------|------|
| V <sub>DD</sub> | Supply voltage (DV <sub>DD</sub> , V <sub>DDL</sub> )                                                           |                  | 4.75               | 5                                  | 5.25 | V    |
| V <sub>SS</sub> | Supply voltage (CV <sub>SS</sub> , V <sub>SSL</sub> , IV <sub>SS</sub> , DV <sub>SS</sub> , V <sub>SUBS</sub> ) |                  | 0                  |                                    |      | V    |
| V <sub>IH</sub> | High-level input voltage                                                                                        | CLKIN            | 2.6                | V <sub>DD</sub> + 0.3 <sup>§</sup> |      | V    |
|                 |                                                                                                                 | All other inputs | 2                  | V <sub>DD</sub> + 0.3 <sup>§</sup> |      | V    |
| V <sub>IL</sub> | Low-level input voltage                                                                                         |                  | − 0.3 <sup>§</sup> |                                    | 0.8  | V    |
| I <sub>OH</sub> | High-level output current                                                                                       |                  | − 300              |                                    |      | μA   |
| I <sub>OL</sub> | Low-level output current                                                                                        |                  | 2                  |                                    |      | mA   |
| T <sub>C</sub>  | Operating case temperature (commercial)                                                                         |                  | 0                  | 85                                 |      | °C   |
|                 | Operating case temperature (extended)                                                                           |                  | − 40               | 125                                |      | °C   |

<sup>‡</sup> All nominal values are at  $V_{DD} = 5$  V,  $T_A$  (ambient air temperature) = 25°C.

<sup>§</sup> These values are derived from characterization and not tested.

NOTE 3: All input and output voltage levels are TTL compatible.

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electrical characteristics over recommended ranges of supply voltage (unless otherwise noted)<sup>†‡</sup>

| PARAMETER       |                                     | TEST CONDITIONS                                     | MIN  | NOM | MAX              | UNIT |
|-----------------|-------------------------------------|-----------------------------------------------------|------|-----|------------------|------|
| V <sub>OH</sub> | High-level output voltage           | V <sub>DD</sub> = MIN, I <sub>OH</sub> = MAX        | 2.4  | 3   |                  | V    |
| V <sub>OL</sub> | Low-level output voltage            | V <sub>DD</sub> = MIN, I <sub>OL</sub> = MAX        |      | 0.3 | 0.6 <sup>§</sup> | V    |
| I <sub>OZ</sub> | High-impedance state output current | V <sub>DD</sub> = MAX                               | – 20 |     | 20               | μA   |
| I <sub>I</sub>  | Input current                       | V <sub>I</sub> = V <sub>SS</sub> to V <sub>DD</sub> | – 10 |     | 10               | μA   |
| I <sub>DD</sub> | Supply current<br>(see Note 4)      | f <sub>X</sub> = 40 MHz                             |      | 160 | 390              | mA   |
|                 |                                     | f <sub>X</sub> = 50 MHz                             |      | 200 | 425              |      |
|                 |                                     | f <sub>X</sub> = 60 MHz                             |      | 225 | 475              |      |
|                 |                                     | Standby                                             |      | 50  |                  | μA   |
| C <sub>I</sub>  | Input capacitance                   | All other inputs                                    |      |     | 15 <sup>¶</sup>  | pF   |
| C <sub>O</sub>  | Output capacitance                  |                                                     |      |     | 20 <sup>¶</sup>  | pF   |

<sup>†</sup> All nominal values are at V<sub>DD</sub> = 5 V, T<sub>A</sub> (ambient air temperature) = 25°C.

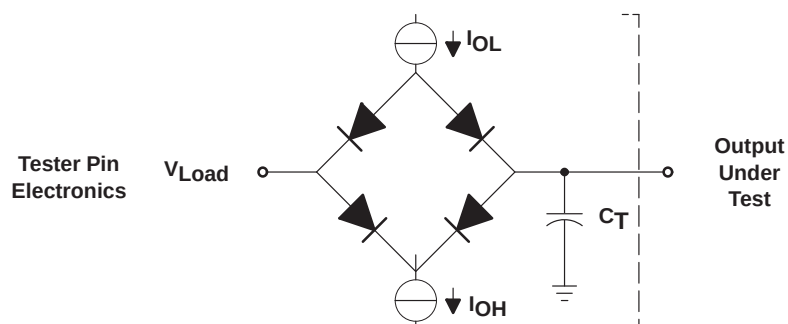
<sup>‡</sup> f<sub>X</sub> is the input clock frequency.

<sup>§</sup> V<sub>OL(max)</sub> = 0.7 V for A(0:23)

<sup>¶</sup> Assured by design but not tested

NOTE 4: Actual operating current is less than this maximum value (reference Note 2).

### PARAMETER MEASUREMENT INFORMATION



Where: I<sub>OL</sub> = 2 mA (all outputs)  
I<sub>OH</sub> = 300 μA (all outputs)  
V<sub>Load</sub> = 2.15 V  
C<sub>T</sub> = 80-pF typical load-circuit capacitance

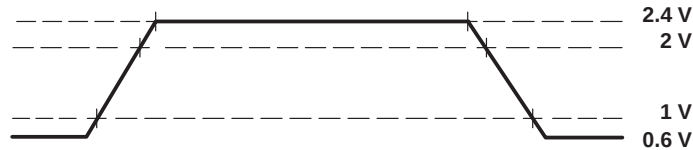
Figure 11. Test Load Circuit

## PARAMETER MEASUREMENT INFORMATION (CONTINUED)

### signal-transition levels for 'C32 (see Figure 12 and Figure 13)

TTL-level outputs are driven to a minimum logic-high level of 2.4 V and to a maximum logic-low level of 0.6 V. Output transition times are specified in the following paragraph.

For a high-to-low transition on an output signal, the level at which the output is said to be no longer high is 2 V and the level at which the output is said to be low is 1 V. For a low-to-high transition, the level at which the output is said to be no longer low is 1 V and the level at which the output is said to be high is 2 V (see Figure 12).



**Figure 12. 'C32 Output Levels**

Transition times for TTL-compatible inputs are specified as follows. For a high-to-low transition on an input signal, the level at which the input is said to be no longer high is 2 V and the level at which the input is said to be low is 0.8 V. For a low-to-high transition on an input signal, the level at which the input is said to be no longer low is 0.8 V and the level at which the input is said to be high is 2 V (see Figure 13).



**Figure 13. 'C32 Input Levels**

**PARAMETER MEASUREMENT INFORMATION (CONTINUED)**

**timing parameter symbology**

Timing parameter symbols used in this document are in accordance with JEDEC Standard 100-A. Unless otherwise noted, in order to shorten the symbols, pin names and other related terminology have been abbreviated as follows:

|     |                                                                                                                                                                                                 |
|-----|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A   | A23–A0 when the physical-memory-width-bit field of the $\overline{\text{STRBx}}$ control register is set to 32 bits                                                                             |
|     | A23–A0 and $\overline{\text{STRBx\_B3/A\_1}}$ when the physical-memory-width-bit field of the $\overline{\text{STRBx}}$ control register is set to 16 bits                                      |
|     | A23–A0, $\overline{\text{STRBx\_B3/A\_1}}$ , and $\overline{\text{STRBx\_B2/A\_2}}$ when the physical-memory-width-bit field of the $\overline{\text{STRBx}}$ control register is set to 8 bits |
| CI  | CLKIN                                                                                                                                                                                           |
| RDY | $\overline{\text{RDY}}$                                                                                                                                                                         |
| D   | D(31–0)                                                                                                                                                                                         |
| H   | H1, H3                                                                                                                                                                                          |
| IOS | $\overline{\text{IOSTRB}}$                                                                                                                                                                      |
| P   | $t_{c(H)}$                                                                                                                                                                                      |
| Q   | $t_{c(Cl)}$                                                                                                                                                                                     |
| RW  | R/ $\overline{W}$                                                                                                                                                                               |
| S   | $\overline{\text{STRBx\_B(3–0)}}$ when the physical-memory-width-bit field of the $\overline{\text{STRBx}}$ control register is set to 32 bits                                                  |
|     | $\overline{\text{STRBx\_B(1–0)}}$ when the physical-memory-width-bit field of the $\overline{\text{STRBx}}$ control register is set to 16 bits                                                  |
|     | $\overline{\text{STRBx\_B0}}$ when the physical-memory-width-bit field of the $\overline{\text{STRBx}}$ control register is set to 8 bits                                                       |
| XF  | XF0 or XF1                                                                                                                                                                                      |

operating characteristics for CLKIN, H1 and H3 [ $Q = t_{c(CI)}$ ] (see Figure 14 and Figure 15)

| NO. | PARAMETERS     |                                     | TEST CONDITIONS  | 'C32-40        |                | 'C32-50        |                | 'C32-60        |                | UNIT |
|-----|----------------|-------------------------------------|------------------|----------------|----------------|----------------|----------------|----------------|----------------|------|
|     |                |                                     |                  | MIN            | MAX            | MIN            | MAX            | MIN            | MAX            |      |
| 1   | $t_{f(CI)}$    | Fall time, CLKIN                    |                  |                | 5 <sup>‡</sup> |                | 5 <sup>‡</sup> |                | 4 <sup>‡</sup> | ns   |
| 2   | $t_{w(CIL)}$   | Pulse duration, CLKIN low           | $Q = \text{MIN}$ | 9              |                | 7              |                | 6              |                | ns   |
| 3   | $t_{w(CIH)}$   | Pulse duration, CLKIN high          | $Q = \text{MIN}$ | 9 <sup>†</sup> |                | 8 <sup>†</sup> |                | 6 <sup>†</sup> |                | ns   |
| 4   | $t_{r(CI)}$    | Rise time, CLKIN                    |                  |                | 5 <sup>‡</sup> |                | 5 <sup>‡</sup> |                | 4 <sup>‡</sup> | ns   |
| 5   | $t_{c(CI)}$    | Cycle time, CLKIN                   |                  | 25             | 303            | 20             | 303            | 16.67          | 303            | ns   |
| 6   | $t_{f(H)}$     | Fall time, H1/H3                    |                  |                | 3              |                | 3              |                | 3              | ns   |
| 7   | $t_{w(HL)}$    | Pulse duration, H1/H3 low           |                  | $Q-5$          |                | $Q-5$          |                | $Q-4$          |                | ns   |
| 8   | $t_{w(HH)}$    | Pulse duration, H1/H3 high          |                  | $Q-6$          |                | $Q-6$          |                | $Q-5$          |                | ns   |
| 9   | $t_{r(H)}$     | Rise time, H1/H3                    |                  |                | 3              |                | 3              |                | 3              | ns   |
| 9.1 | $t_{d(HL-HH)}$ | Delay time, H1/H3 low to H1/H3 high |                  | 0              | 4              | 0              | 4              | 0              | 4              | ns   |
| 10  | $t_{c(H)}$     | Cycle time, H1/H3                   |                  | 50             | 606            | 40             | 606            | 33.33          | 606            | ns   |

<sup>†</sup> The minimum CLKIN high pulse duration at 3.3 MHz is 10 ns.

<sup>‡</sup> Assured by design but not tested

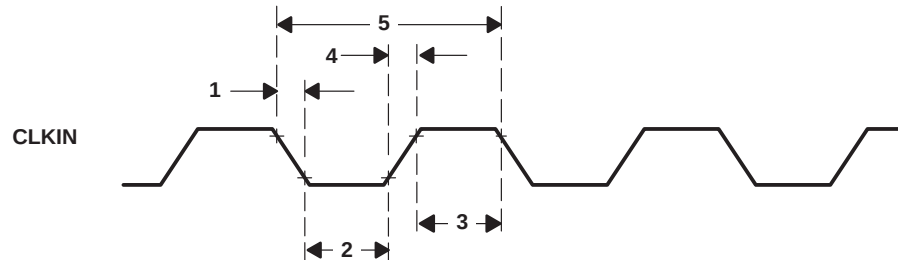


Figure 14. CLKIN Timing

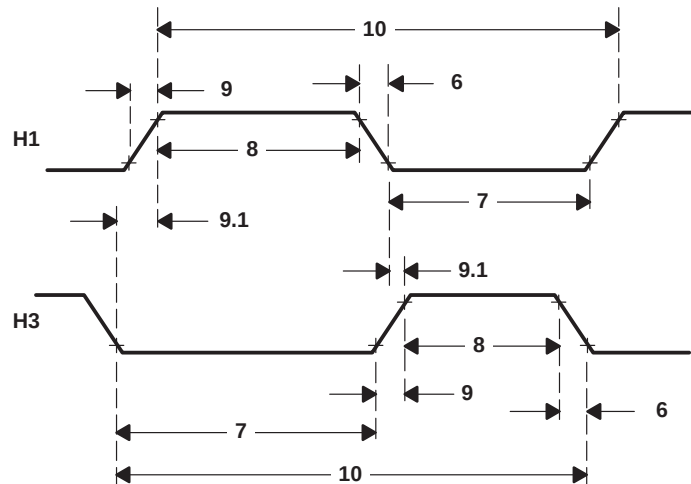


Figure 15. H1/H3 Timing

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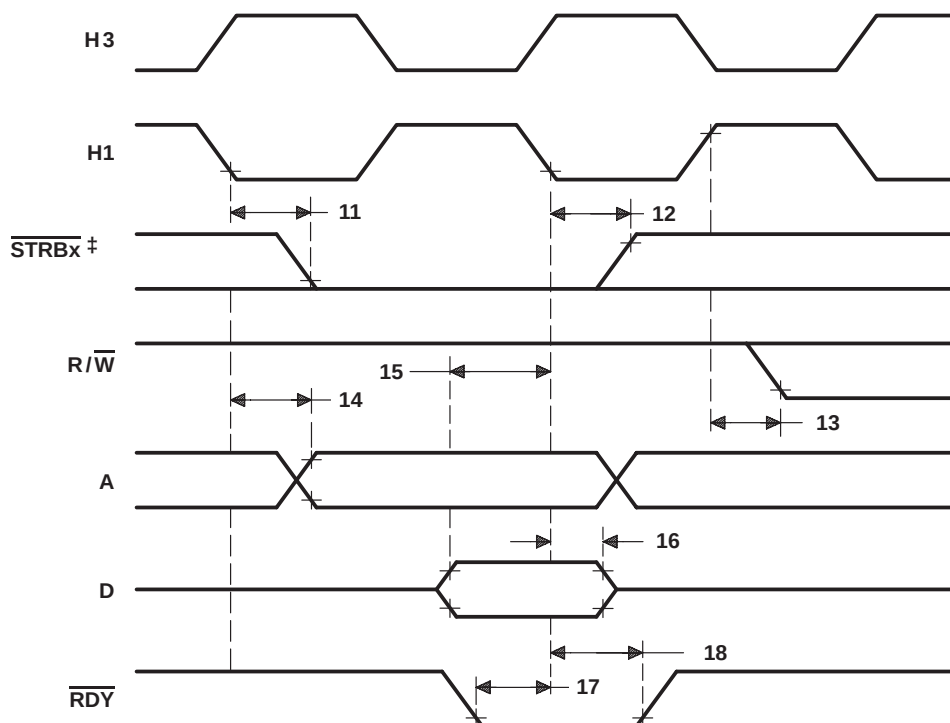
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### memory-read-cycle and memory-write-cycle timing ( $\overline{\text{STRBx}}$ ) (see Figure 16 and Figure 17)

| NO. |                  |                                                             | 'C32 - 40      |     | 'C32 - 50      |     | 'C32 - 60      |     | UNIT |
|-----|------------------|-------------------------------------------------------------|----------------|-----|----------------|-----|----------------|-----|------|
|     |                  |                                                             | MIN            | MAX | MIN            | MAX | MIN            | MAX |      |
| 11  | $t_{d(H1L-SL)}$  | Delay time, H1 low to $\overline{\text{STRBx}}$ low         | 0 <sup>†</sup> | 11  | 0 <sup>†</sup> | 9   | 0 <sup>†</sup> | 7   | ns   |
| 12  | $t_{d(H1L-SH)}$  | Delay time, H1 low to $\overline{\text{STRBx}}$ high        | 0 <sup>†</sup> | 11  | 0 <sup>†</sup> | 9   | 0 <sup>†</sup> | 7   | ns   |
| 13  | $t_{d(H1H-RWL)}$ | Delay time, H1 high to R/ $\overline{W}$ low (read)         | 0 <sup>†</sup> | 11  | 0 <sup>†</sup> | 9   | 0 <sup>†</sup> | 8   | ns   |
| 14  | $t_{d(H1L-A)}$   | Delay time, H1 low to A valid                               | 0 <sup>†</sup> | 11  | 0 <sup>†</sup> | 9   | 0 <sup>†</sup> | 7   | ns   |
| 15  | $t_{su(D)R}$     | Setup time, D valid before H1 low (read)                    | 13             |     | 10             |     | 10             |     | ns   |
| 16  | $t_{h(D)R}$      | Hold time, D after H1 low (read)                            | 0              |     | 0              |     | 0              |     | ns   |
| 17  | $t_{su(RDY)}$    | Setup time, $\overline{\text{RDY}}$ before H1 low           | 21             |     | 19             |     | 17             |     | ns   |
| 18  | $t_{h(RDY)}$     | Hold time, $\overline{\text{RDY}}$ after H1 low             | 0              |     | 0              |     | 0              |     | ns   |
| 19  | $t_{d(H1H-RWH)}$ | Delay time, H1 high to R/ $\overline{W}$ high (write)       |                | 11  |                | 9   |                | 8   | ns   |
| 20  | $t_{v(D)W}$      | Valid time, D after H1 low (write)                          |                | 17  |                | 14  |                | 12  | ns   |
| 21  | $t_{h(D)W}$      | Hold time, D after H1 high (write)                          | 0              |     | 0              |     | 0              |     | ns   |
| 22  | $t_{d(H1H-A)}$   | Delay time, H1 high to A valid on back-to-back write cycles |                | 11  |                | 9   |                | 8   | ns   |

<sup>†</sup> Assured from characterization but not tested



<sup>‡</sup>  $\overline{\text{STRBx}}$  remains low during back-to-back operations.

Figure 16. Memory-Read-Cycle Timing

memory-read-cycle and memory-write-cycle timing ( $\overline{\text{STRBx}}$ ) (see Figure 16 and Figure 17)  
(continued)

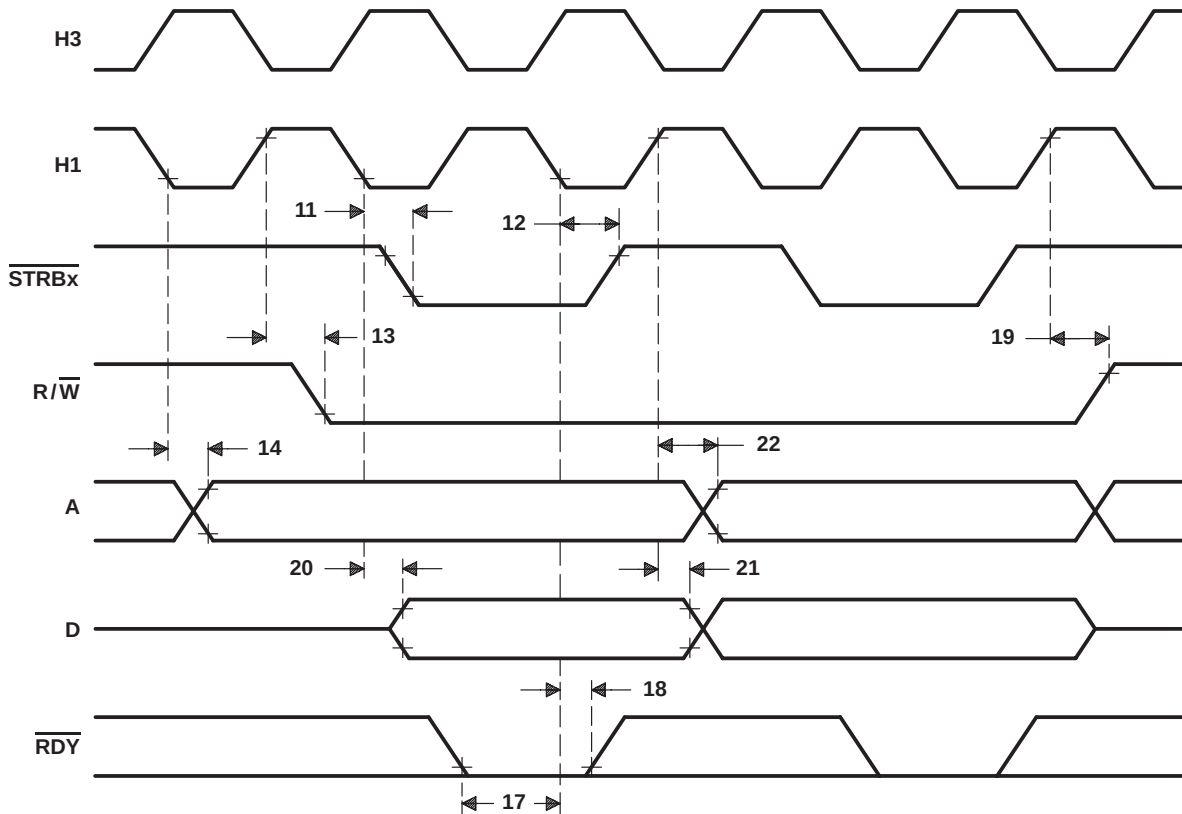


Figure 17. Memory-Write-Cycle Timing

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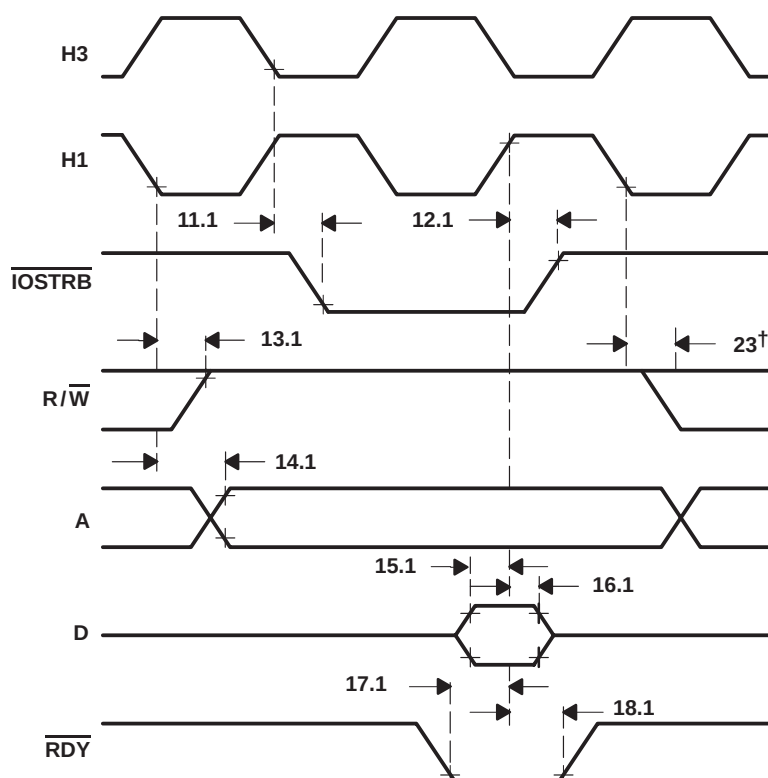
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### memory-read-cycle timing using $\overline{\text{IOSTRB}}$ (see Figure 18)

| NO.  |                                                                                 | 'C32 - 40      |     | 'C32 - 50      |     | 'C32 - 60      |     | UNIT |
|------|---------------------------------------------------------------------------------|----------------|-----|----------------|-----|----------------|-----|------|
|      |                                                                                 | MIN            | MAX | MIN            | MAX | MIN            | MAX |      |
| 11.1 | $t_d(\text{H3L-IOSL})$ Delay time, H3 low to $\overline{\text{IOSTRB}}$ low     | 0 <sup>†</sup> | 11  | 0 <sup>†</sup> | 9   | 0 <sup>†</sup> | 8   | ns   |
| 12.1 | $t_d(\text{H3L-IOSH})$ Delay time, H3 low to $\overline{\text{IOSTRB}}$ high    | 0 <sup>†</sup> | 11  | 0 <sup>†</sup> | 9   | 0 <sup>†</sup> | 8   | ns   |
| 13.1 | $t_d(\text{H1L-RWL})$ Delay time, H1 low to $\text{R}/\overline{\text{W}}$ high | 0 <sup>†</sup> | 11  | 0 <sup>†</sup> | 9   | 0 <sup>†</sup> | 8   | ns   |
| 14.1 | $t_d(\text{H1L-A})$ Delay time, H1 low to A valid                               | 0 <sup>†</sup> | 11  | 0 <sup>†</sup> | 9   | 0 <sup>†</sup> | 8   | ns   |
| 15.1 | $t_{\text{su}}(\text{D})\text{R}$ Setup time, D before H1 high                  | 13             |     | 10             |     | 9              |     | ns   |
| 16.1 | $t_{\text{h}}(\text{D})\text{R}$ Hold time, D after H1 high                     | 0              |     | 0              |     | 0              |     | ns   |
| 17.1 | $t_{\text{su}}(\text{RDY})$ Setup time, $\overline{\text{RDY}}$ before H1 high  | 9              |     | 8              |     | 7              |     | ns   |
| 18.1 | $t_{\text{h}}(\text{RDY})$ Hold time, $\overline{\text{RDY}}$ after H1 high     | 0              |     | 0              |     | 0              |     | ns   |
| 23   | $t_d(\text{H1L-RWH})$ Delay time, H1 low to $\text{R}/\overline{\text{W}}$ low  | 0 <sup>†</sup> | 11  | 0 <sup>†</sup> | 9   | 0 <sup>†</sup> | 8   | ns   |

<sup>†</sup> Assured from characterization but not tested



<sup>†</sup> See Figure 19 and accompanying table.

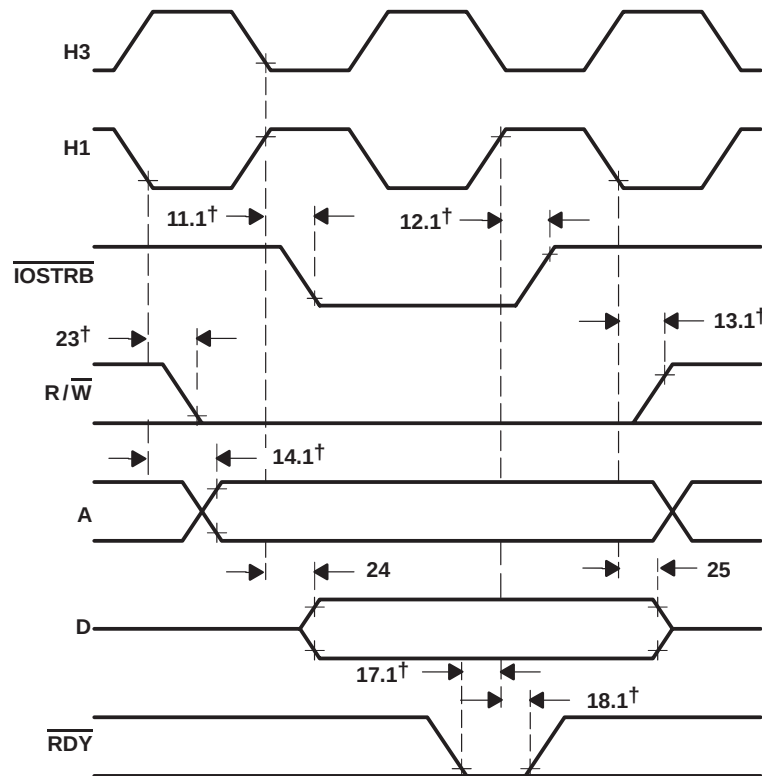
**Figure 18. Memory-Read-Cycle Timing Using  $\overline{\text{IOSTRB}}$**



**memory-write-cycle timing using  $\overline{\text{IOSTRB}}$  (see Figure 19)**

| NO.  |                                                                                       | 'C32-40        |     | 'C32-50        |     | 'C32-60        |     | UNIT |
|------|---------------------------------------------------------------------------------------|----------------|-----|----------------|-----|----------------|-----|------|
|      |                                                                                       | MIN            | MAX | MIN            | MAX | MIN            | MAX |      |
| 11.1 | $t_{\text{d}}(\text{H3L-IOSL})$ Delay time, H3 low to $\overline{\text{IOSTRB}}$ low  | 0 <sup>†</sup> | 11  | 0 <sup>†</sup> | 9   | 0 <sup>†</sup> | 8   | ns   |
| 12.1 | $t_{\text{d}}(\text{H3L-IOSH})$ Delay time, H3 low to $\overline{\text{IOSTRB}}$ high | 0 <sup>†</sup> | 11  | 0 <sup>†</sup> | 9   | 0 <sup>†</sup> | 8   | ns   |
| 13.1 | $t_{\text{d}}(\text{H1L-RWL})$ Delay time, H1 low to R/ $\overline{\text{W}}$ high    | 0 <sup>†</sup> | 11  | 0 <sup>†</sup> | 9   | 0 <sup>†</sup> | 8   | ns   |
| 14.1 | $t_{\text{d}}(\text{H1L-A})$ Delay time, H1 low to A valid                            | 0 <sup>†</sup> | 11  | 0 <sup>†</sup> | 9   | 0 <sup>†</sup> | 8   | ns   |
| 17.1 | $t_{\text{su}}(\text{RDY})$ Setup time, $\overline{\text{RDY}}$ before H1 high        | 9              |     | 8              |     | 7              |     | ns   |
| 18.1 | $t_{\text{h}}(\text{RDY})$ Hold time, $\overline{\text{RDY}}$ after H1 high           | 0              |     | 0              |     | 0              |     | ns   |
| 23   | $t_{\text{d}}(\text{H1L-RWH})$ Delay time, H1 low to R/ $\overline{\text{W}}$ low     | 0 <sup>†</sup> | 11  | 0 <sup>†</sup> | 9   | 0 <sup>†</sup> | 8   | ns   |
| 24   | $t_{\text{v}}(\text{D})\text{W}$ Valid time, D after H1 high                          |                | 17  |                | 14  |                | 12  | ns   |
| 25   | $t_{\text{h}}(\text{D})\text{W}$ Hold time, D after H1 low                            | 0              |     | 0              |     | 0              |     | ns   |

<sup>†</sup> Assured from characterization but not tested



<sup>†</sup> See Figure 18 and accompanying table.

**Figure 19. Memory-Write-Cycle Timing Using  $\overline{\text{IOSTRB}}$**

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timing for XF0 and XF1 when executing LDFI or LDII (see Figure 20)

| NO. |                                                  | 'C32 - 40 |     | 'C32 - 50 |     | 'C32 - 60 |     | UNIT |
|-----|--------------------------------------------------|-----------|-----|-----------|-----|-----------|-----|------|
|     |                                                  | MIN       | MAX | MIN       | MAX | MIN       | MAX |      |
| 38  | $t_{d(H3H-XF0L)}$ Delay time, H3 high to XF0 low |           | 13  |           | 12  |           | 11  | ns   |
| 39  | $t_{su(XF1)}$ Setup time, XF1 before H1 low      | 9         |     | 9         |     | 8         |     | ns   |
| 40  | $t_{h(XF1)}$ Hold time, XF1 after H1 low         | 0         |     | 0         |     | 0         |     | ns   |

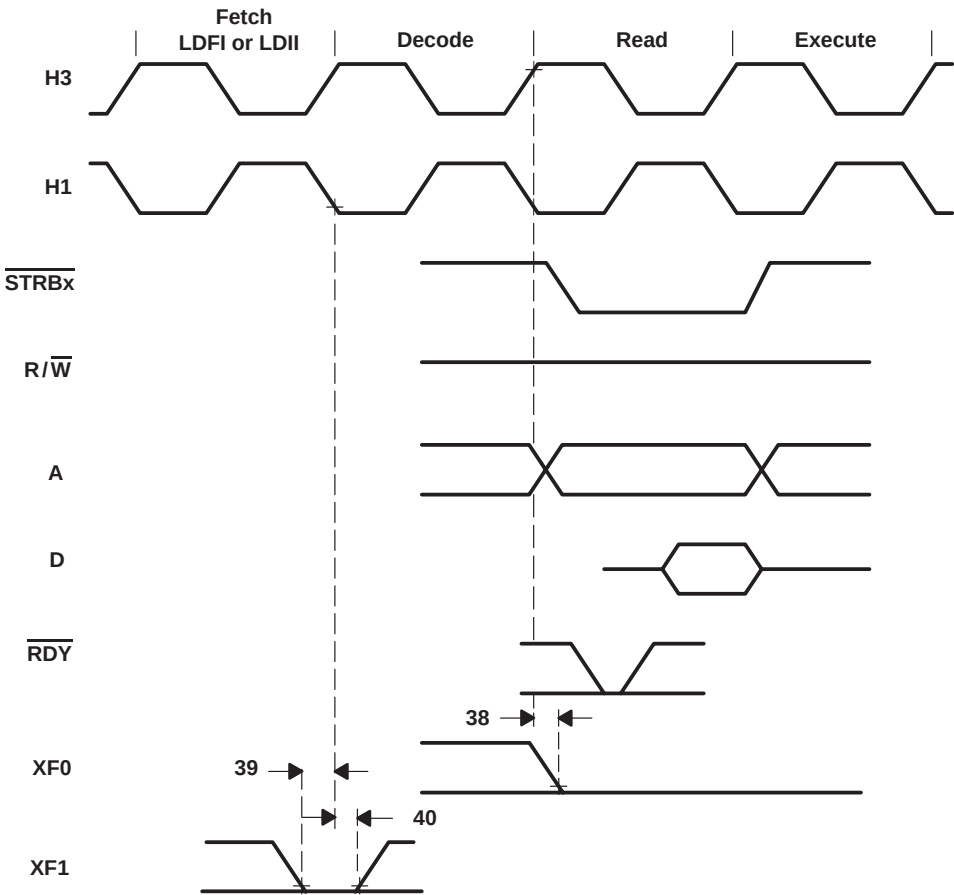


Figure 20. XF0 and XF1 When Executing LDFI or LDII

timing for XF0 when executing STFI or STII<sup>†</sup> (see Figure 21)

| NO. |                                                   | 'C32-40 |     | 'C32-50 |     | 'C32-60 |     | UNIT |
|-----|---------------------------------------------------|---------|-----|---------|-----|---------|-----|------|
|     |                                                   | MIN     | MAX | MIN     | MAX | MIN     | MAX |      |
| 41  | $t_{d(H3H-XF0H)}$ Delay time, H3 high to XF0 high | 13      |     | 12      |     | 11      |     | ns   |

<sup>†</sup> XF0 is always set high at the beginning of the execute phase of the interlock-store instruction. When no pipeline conflicts occur, the address of the store is driven at the beginning of the execute phase of the interlock-store instruction. However, if a pipeline conflict prevents the store from executing, the address of the store is not driven until the store can execute.

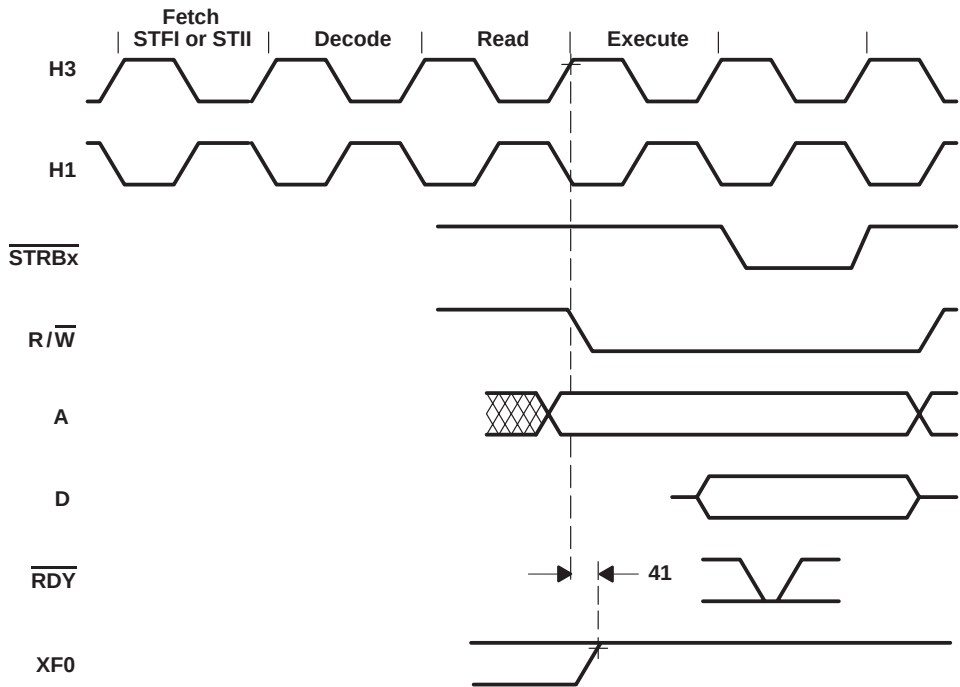


Figure 21. XF0 When Executing a STFI or STII

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### timing for XF0 and XF1 when executing SIGI (see Figure 22)

| NO.  |                                                   | 'C32-40 |     | 'C32-50 |     | 'C32-60 |     | UNIT |
|------|---------------------------------------------------|---------|-----|---------|-----|---------|-----|------|
|      |                                                   | MIN     | MAX | MIN     | MAX | MIN     | MAX |      |
| 41.1 | $t_{d(H3H-XF0L)}$ Delay time, H3 high to XF0 low  | 13      |     | 12      |     | 11      |     | ns   |
| 42   | $t_{d(H3H-XF0H)}$ Delay time, H3 high to XF0 high | 13      |     | 12      |     | 11      |     | ns   |
| 43   | $t_{su(XF1)}$ Setup time, XF1 before H1 low       | 9       |     | 9       |     | 8       |     | ns   |
| 44   | $t_h(XF1)$ Hold time, XF1 after H1 low            | 0       |     | 0       |     | 0       |     | ns   |

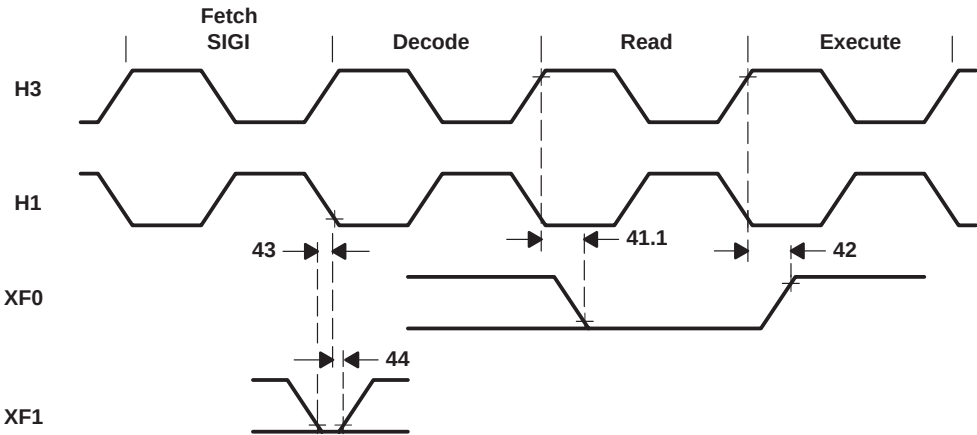
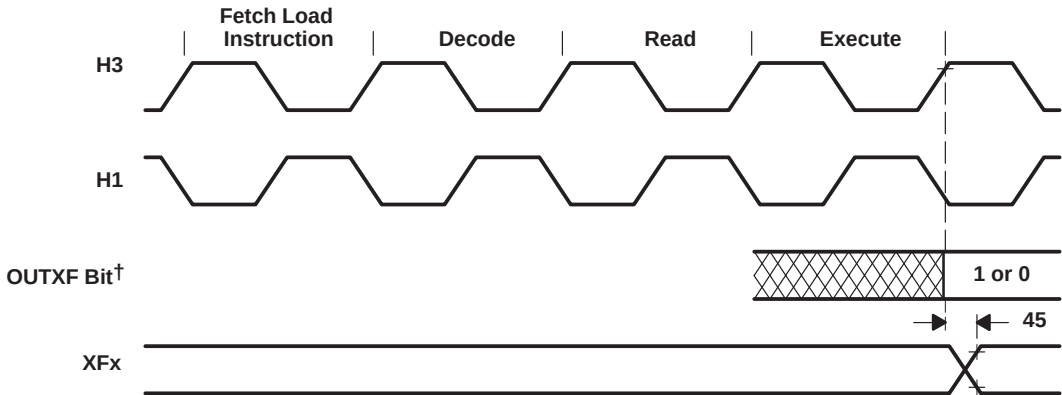


Figure 22. XF0 and XF1 When Executing SIGI

### timing for loading XF register when configured as an output pin (see Figure 23)

| NO. |                                               | 'C32-40 |     | 'C32-50 |     | 'C32-60 |     | UNIT |
|-----|-----------------------------------------------|---------|-----|---------|-----|---------|-----|------|
|     |                                               | MIN     | MAX | MIN     | MAX | MIN     | MAX |      |
| 45  | $t_v(H3H-XF)$ Valid time, H3 high to XF valid | 13      |     | 12      |     | 11      |     | ns   |



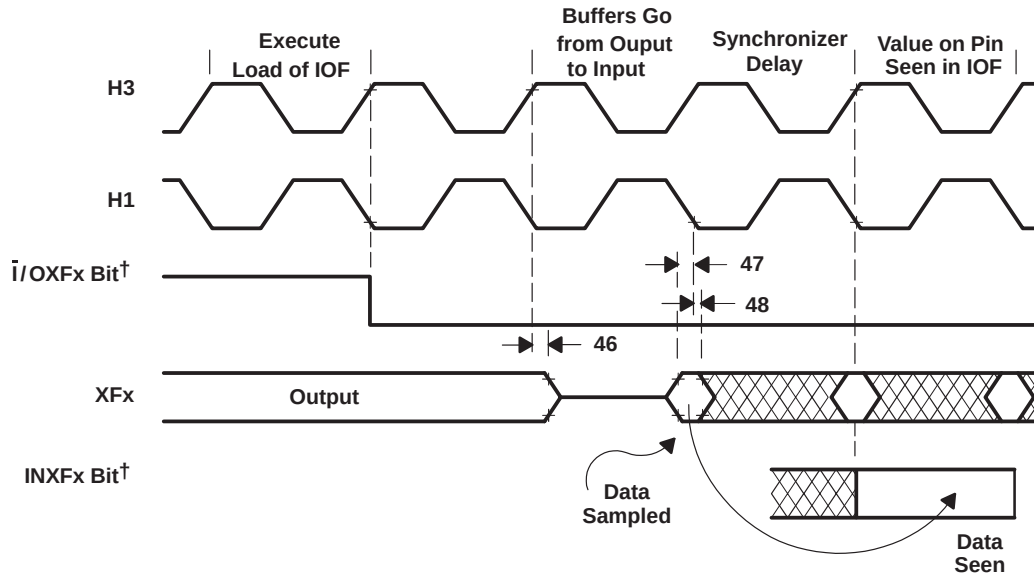
† OUTXFx represents either bit 2 or 6 of the IOF register.

Figure 23. Loading XF Register When Configured as an Output Pin

**timing of XF changing from output to input mode (see Figure 24)**

| NO. |                                             | 'C32-40 |                 | 'C32-50 |                 | 'C32-60 |                 | UNIT |
|-----|---------------------------------------------|---------|-----------------|---------|-----------------|---------|-----------------|------|
|     |                                             | MIN     | MAX             | MIN     | MAX             | MIN     | MAX             |      |
| 46  | $t_h(H3H-XF01)$ Hold time, XF after H3 high |         | 13 <sup>†</sup> |         | 12 <sup>†</sup> |         | 11 <sup>†</sup> | ns   |
| 47  | $t_{su}(XF)$ Setup time, XF before H1 low   | 9       |                 | 9       |                 | 8       |                 | ns   |
| 48  | $t_h(XF)$ Hold time, XF after H1 low        | 0       |                 | 0       |                 | 0       |                 | ns   |

<sup>†</sup> Assured from characterization but not tested



<sup>†</sup> I/OXFx represents either bit 1 or bit 5 of the IOF register, and INXFx represents either bit 3 or bit 7 of the IOF register.

**Figure 24. Change of XF From Output to Input Mode**

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### timing of XF changing from input to output mode (see Figure 25)

| NO. |                                                                            | 'C32 - 40 |     | 'C32 - 50 |     | 'C32 - 60 |     | UNIT |
|-----|----------------------------------------------------------------------------|-----------|-----|-----------|-----|-----------|-----|------|
|     |                                                                            | MIN       | MAX | MIN       | MAX | MIN       | MAX |      |
| 49  | $t_{d(H3H-XFIO)}$ Delay time, H3 high to XF switching from input to output |           | 17  |           | 17  |           | 15  | ns   |

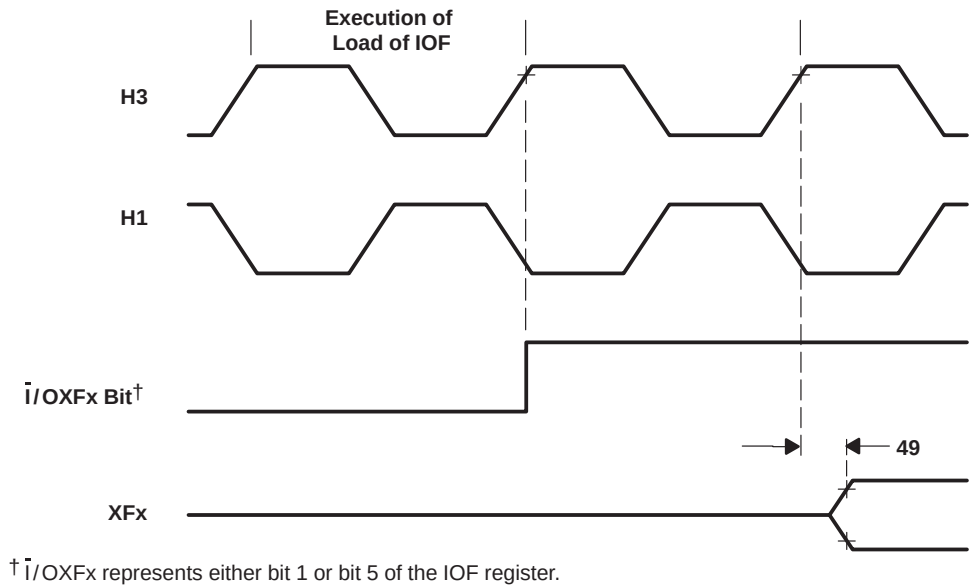


Figure 25. Change of XF From Input to Output Mode

**timing for  $\overline{\text{RESET}}$  [ $Q = t_c(CI)$ ] (see Figure 26)**

| NO.  |                                 |                                                                                                       | 'C32-40 |               | 'C32-50 |               | 'C32-60 |               | UNIT |
|------|---------------------------------|-------------------------------------------------------------------------------------------------------|---------|---------------|---------|---------------|---------|---------------|------|
|      |                                 |                                                                                                       | MIN     | MAX           | MIN     | MAX           | MIN     | MAX           |      |
| 50   | $t_{su}(\text{RESET})$          | Setup time, $\overline{\text{RESET}}$ before CLKIN low                                                | 10      | $Q^\dagger$   | 10      | $Q^\dagger$   | 7       | $Q^\dagger$   | ns   |
| 51   | $t_d(\text{CLKINH-H1H})$        | Delay time, CLKIN high to H1 high                                                                     | 2       | 12            | 2       | 10            | 2       | 10            | ns   |
| 52   | $t_d(\text{CLKINH-H1L})$        | Delay time, CLKIN high to H1 low                                                                      | 2       | 12            | 2       | 10            | 2       | 10            | ns   |
| 53   | $t_{su}(\text{RESETH-H1L})$     | Setup time, $\overline{\text{RESET}}$ high before H1 low and after ten H1 clock cycles                | 9       |               | 7       |               | 6       |               | ns   |
| 54   | $t_d(\text{CLKINH-H3L})$        | Delay time, CLKIN high to H3 low                                                                      | 2       | 12            | 2       | 10            | 2       | 10            | ns   |
| 55   | $t_d(\text{CLKINH-H3H})$        | Delay time, CLKIN high to H3 high                                                                     | 2       | 12            | 2       | 10            | 2       | 10            | ns   |
| 56   | $t_{dis}(\text{H1H-D})$         | Disable time, H1 low to D in the high-impedance state                                                 |         | $13^\ddagger$ |         | $12^\ddagger$ |         | $11^\ddagger$ | ns   |
| 57   | $t_{dis}(\text{H3HL-A})$        | Disable time, H3 low to A in the high-impedance state                                                 |         | $9^\ddagger$  |         | $8^\ddagger$  |         | $7^\ddagger$  | ns   |
| 58.1 | $t_d(\text{H3H-CONTROLH})$      | Delay time, H3 high to control signals high                                                           |         | $9^\ddagger$  |         | $8^\ddagger$  |         | $7^\ddagger$  | ns   |
| 58.2 | $t_d(\text{H1H-RWH})$           | Delay time, H1 low to $R/\overline{W}$ high                                                           |         | $9^\ddagger$  |         | $8^\ddagger$  |         | $7^\ddagger$  | ns   |
| 59   | $t_d(\text{H1H-IACKH})$         | Delay time, H1 high to $\overline{\text{IACK}}$ high                                                  |         | $9^\ddagger$  |         | $8^\ddagger$  |         | $7^\ddagger$  | ns   |
| 60   | $t_{dis}(\text{RESETL-ASYNCH})$ | Disable time, $\overline{\text{RESET}}$ low to asynchronous reset signals in the high-impedance state |         | $21^\ddagger$ |         | $17^\ddagger$ |         | $14^\ddagger$ | ns   |

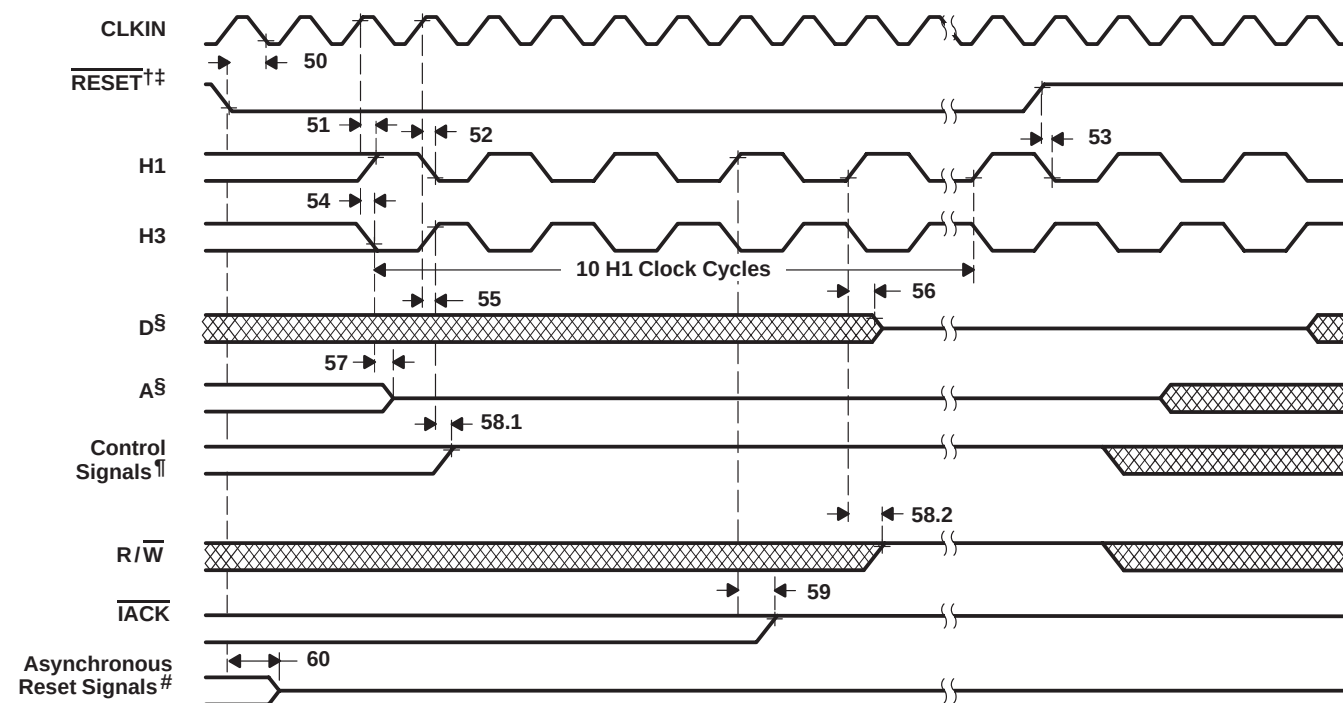
$^\dagger$  Assured by design but not tested

$^\ddagger$  Assured from characterization but not tested

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## timing for $\overline{\text{RESET}}$ [ $Q = t_{c(CI)}$ ] (continued)



†  $\overline{\text{RESET}}$  is an asynchronous input and can be asserted at any point during a clock cycle. If the specified timings are met, the exact sequence shown occurs; otherwise, an additional delay of one clock cycle can occur.

‡ The R/W output is placed in the high-impedance state during reset and can be provided with a resistive pullup, nominally 18–22 k $\Omega$ , if undesirable spurious writes can occur when these outputs go low.

§ In microprocessor mode ( $\text{MCBL}/\text{MP} = 0$ ), reset vector is fetched twice with seven software wait states each. In microcomputer mode ( $\text{MCBL}/\text{MP} = 1$ ), the reset vector is fetched two times, with no software wait states.

¶ Control signals include  $\overline{\text{STRB}}$  and  $\overline{\text{IOSTRB}}$ .

# Asynchronous reset signals include XF0/1, CLKX0, DX0, FSX0, CLKR0, DR0, FSR0, and TCLKx.

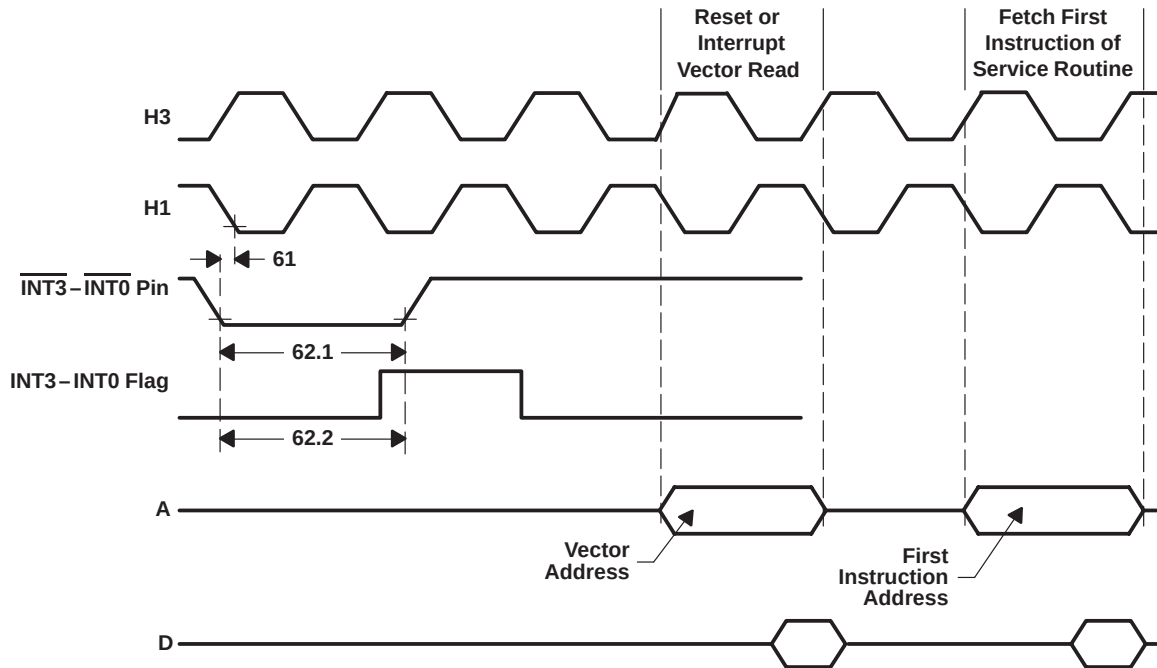
Figure 26.  $\overline{\text{RESET}}$  Timing



**timing for  $\overline{\text{INT3}}-\overline{\text{INT0}}$  interrupt response [ $P = t_{c(H)}$ ] (see Figure 27)**

| NO.  |                                                                                                                  | 'C32-40     |              | 'C32-50     |              | 'C32-60     |              | UNIT |
|------|------------------------------------------------------------------------------------------------------------------|-------------|--------------|-------------|--------------|-------------|--------------|------|
|      |                                                                                                                  | MIN         | MAX          | MIN         | MAX          | MIN         | MAX          |      |
| 61   | $t_{\text{su(INT)}}$ Setup time, $\overline{\text{INT3}}-\overline{\text{INT0}}$ before H1 low                   | 13          |              | 10          |              | 8           |              | ns   |
| 62.1 | $t_{\text{w(INT)}}$ Pulse duration of interrupt to assure only one interrupt seen for level-triggered interrupts | P           | $2P^\dagger$ | P           | $2P^\dagger$ | P           | $2P^\dagger$ | ns   |
| 62.2 | $t_{\text{w(INT)}}$ Pulse duration of interrupt for edge-triggered interrupts                                    | $P^\dagger$ |              | $P^\dagger$ |              | $P^\dagger$ |              | ns   |

<sup>†</sup> Assured from characterization but not tested.



**Figure 27.  $\overline{\text{INT3}}-\overline{\text{INT0}}$  Interrupt-Response Timing**

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timing for  $\overline{\text{IACK}}$  (see Notes 5 and Figure 28)

| NO. |                                                                         | 'C32 - 40 |     | 'C32 - 50 |     | 'C32 - 60 |     | UNIT |
|-----|-------------------------------------------------------------------------|-----------|-----|-----------|-----|-----------|-----|------|
|     |                                                                         | MIN       | MAX | MIN       | MAX | MIN       | MAX |      |
| 63  | $t_{d(H1H-IACKL)}$ Delay time, H1 high to $\overline{\text{IACK}}$ low  |           | 9   |           | 7   |           | 6   | ns   |
| 64  | $t_{d(H1H-IACKH)}$ Delay time, H1 high to $\overline{\text{IACK}}$ high |           | 9   |           | 7   |           | 6   | ns   |

NOTES: 5.  $\overline{\text{IACK}}$  is active for the entire duration of the bus cycle and is extended if the bus cycle utilizes wait states.

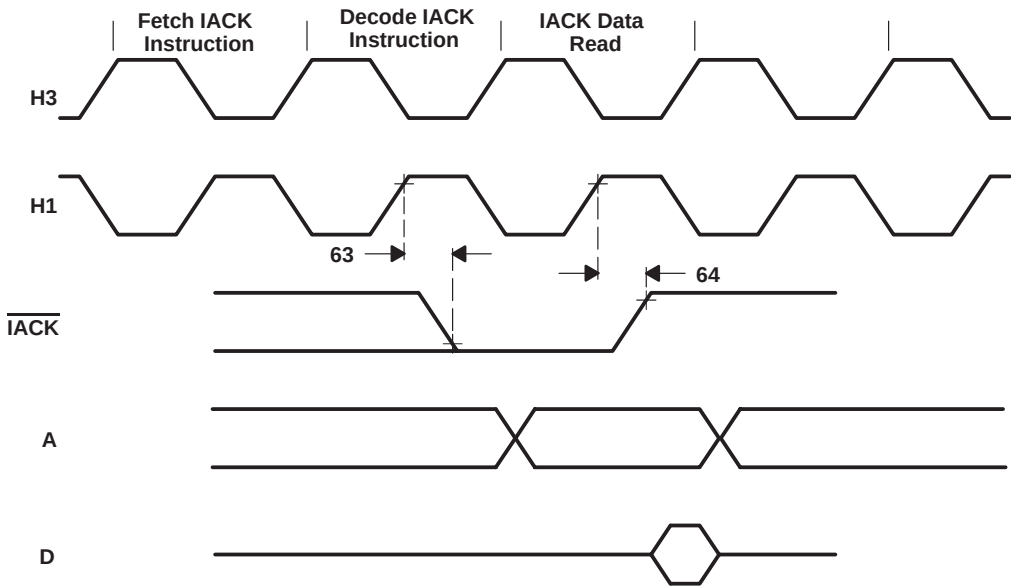


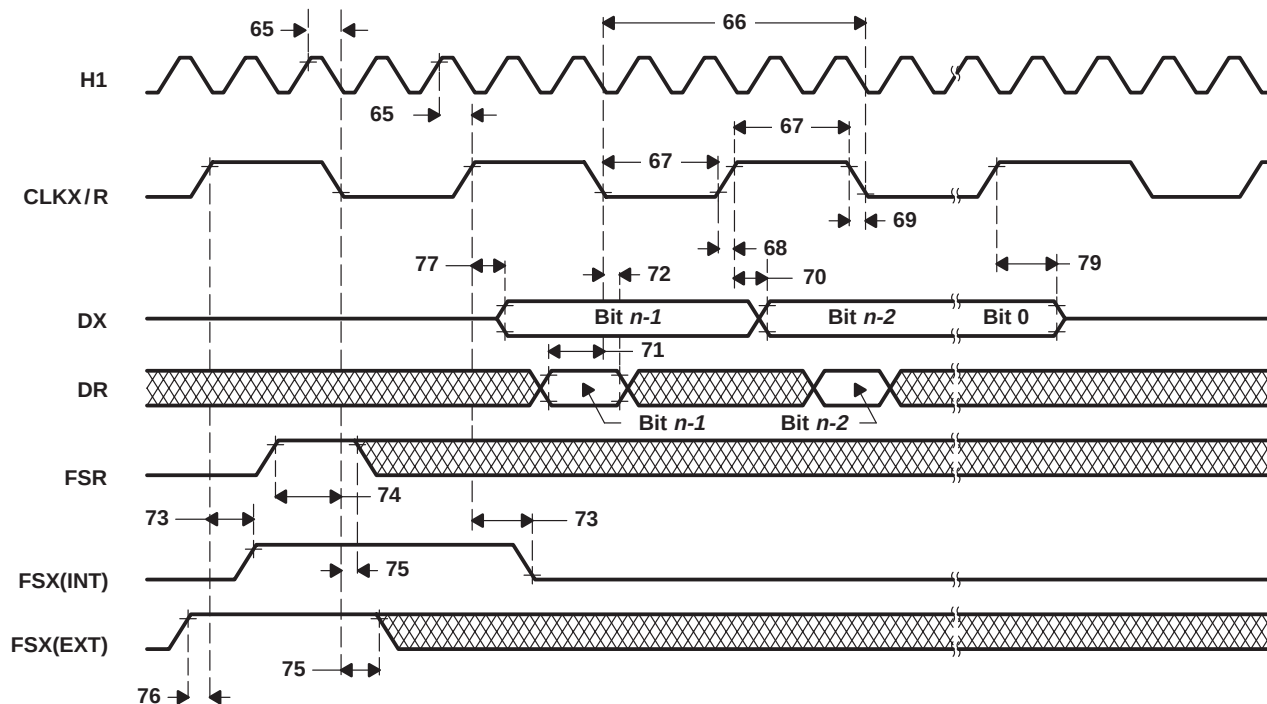
Figure 28.  $\overline{\text{IACK}}$  Timing

**serial-port timing [P = t<sub>c(H)</sub>] (see Figure 29 and Figure 30)**

| NO. |                         |                                                                                 | 'C32 - 40                    |                                     | 'C32 - 50                                |                                     | 'C32 - 60                                |                                     | UNIT                                     |    |
|-----|-------------------------|---------------------------------------------------------------------------------|------------------------------|-------------------------------------|------------------------------------------|-------------------------------------|------------------------------------------|-------------------------------------|------------------------------------------|----|
|     |                         |                                                                                 | MIN                          | MAX                                 | MIN                                      | MAX                                 | MIN                                      | MAX                                 |                                          |    |
| 65  | t <sub>d(H1-SCK)</sub>  | Delay time, H1 high to internal CLKX/R high/low                                 | 13                           |                                     | 10                                       |                                     | 8                                        |                                     | ns                                       |    |
| 66  | t <sub>c(SCK)</sub>     | Cycle time, CLKX/R                                                              | CLKX/R ext                   | 2.6P                                | 2.6P                                     |                                     | 2.6P                                     |                                     | ns                                       |    |
|     |                         | CLKX/R int                                                                      | 2P                           | (2 <sup>32</sup> )P                 | 2P                                       | (2 <sup>32</sup> )P                 | 2P                                       | (2 <sup>32</sup> )P                 |                                          |    |
| 67  | t <sub>w(SCK)</sub>     | Pulse duration, CLKX/R high/low                                                 | CLKX/R ext                   | P + 10                              | P + 10                                   |                                     | P + 10                                   |                                     | ns                                       |    |
|     |                         | CLKX/R int                                                                      | [t <sub>c(SCK)</sub> /2] – 5 | [t <sub>c(SCK)</sub> /2] + 5        | [t <sub>c(SCK)</sub> /2] – 5             | [t <sub>c(SCK)</sub> /2] + 5        | [t <sub>c(SCK)</sub> /2] – 5             | [t <sub>c(SCK)</sub> /2] + 5        |                                          |    |
| 68  | t <sub>r(SCK)</sub>     | Rise time, CLKX/R                                                               | 7                            |                                     | 6                                        |                                     | 5                                        |                                     | ns                                       |    |
| 69  | t <sub>f(SCK)</sub>     | Fall time, CLKX/R                                                               | 7                            |                                     | 6                                        |                                     | 5                                        |                                     | ns                                       |    |
| 70  | t <sub>d(DX)</sub>      | Delay time, CLKX to DX valid                                                    | CLKX ext                     | 30                                  | 24                                       |                                     | 20                                       |                                     | ns                                       |    |
|     |                         | CLKX int                                                                        | 17                           | 16                                  |                                          | 15                                  |                                          |                                     |                                          |    |
| 71  | t <sub>su(DR)</sub>     | Setup time, DR before CLKR low                                                  | CLKR ext                     | 9                                   | 9                                        |                                     | 8                                        |                                     | ns                                       |    |
|     |                         | CLKR int                                                                        | 21                           | 17                                  |                                          | 15                                  |                                          |                                     |                                          |    |
| 72  | t <sub>h(DR)</sub>      | Hold time, DR from CLKR low                                                     | CLKR ext                     | 9                                   | 7                                        |                                     | 6                                        |                                     | ns                                       |    |
|     |                         | CLKR int                                                                        | 0                            | 0                                   |                                          | 0                                   |                                          | ns                                  |                                          |    |
| 73  | t <sub>d(FSX)</sub>     | Delay time, CLKX to internal FSX high/low                                       | CLKX ext                     | 27                                  | 22                                       |                                     | 20                                       |                                     | ns                                       |    |
|     |                         | CLKX int                                                                        | 15                           | 15                                  |                                          | 14                                  |                                          |                                     |                                          |    |
| 74  | t <sub>su(FSR)</sub>    | Setup time, FSR before CLKR low                                                 | CLKR ext                     | 9                                   | 7                                        |                                     | 6                                        |                                     | ns                                       |    |
|     |                         | CLKR int                                                                        | 9                            | 7                                   |                                          | 6                                   |                                          |                                     |                                          |    |
| 75  | t <sub>h(FS)</sub>      | Hold time, FSX/R input from CLKX/R low                                          | CLKX/R ext                   | 9                                   | 7                                        |                                     | 6                                        |                                     | ns                                       |    |
|     |                         | CLKX/R int                                                                      | 0                            | 0                                   |                                          | 0                                   |                                          |                                     |                                          |    |
| 76  | t <sub>su(FSX)</sub>    | Setup time, external FSX before CLKX high                                       | CLKX ext                     | 8 – P <sup>†</sup>                  | [t <sub>c(SCK)</sub> /2]–10 <sup>†</sup> | 8 – P <sup>†</sup>                  | [t <sub>c(SCK)</sub> /2]–10 <sup>†</sup> | 8 – P <sup>†</sup>                  | [t <sub>c(SCK)</sub> /2]–10 <sup>†</sup> | ns |
|     |                         | CLKX int                                                                        | 21 – P <sup>†</sup>          | t <sub>c(SCK)</sub> /2 <sup>†</sup> | 21 – P <sup>†</sup>                      | t <sub>c(SCK)</sub> /2 <sup>†</sup> | 21 – P <sup>†</sup>                      | t <sub>c(SCK)</sub> /2 <sup>†</sup> |                                          |    |
| 77  | t <sub>d(CH-DX)V</sub>  | Delay time, CLKX to first DX bit, FSX precedes CLKX high                        | CLKX ext                     | 30 <sup>†</sup>                     | 24 <sup>†</sup>                          |                                     | 20 <sup>†</sup>                          |                                     | ns                                       |    |
|     |                         | CLKX int                                                                        | 18 <sup>†</sup>              | 14 <sup>†</sup>                     |                                          | 12 <sup>†</sup>                     |                                          |                                     |                                          |    |
| 78  | t <sub>d(FSX-DX)V</sub> | Delay time, FSX to first DX bit, CLKX precedes FSX                              | 30 <sup>†</sup>              |                                     | 24 <sup>†</sup>                          |                                     | 20 <sup>†</sup>                          |                                     | ns                                       |    |
| 79  | t <sub>d(DXZ)</sub>     | Delay time, CLKX high to DX in the high-impedance state following last data bit | 17 <sup>†</sup>              |                                     | 14 <sup>†</sup>                          |                                     | 12 <sup>†</sup>                          |                                     | ns                                       |    |

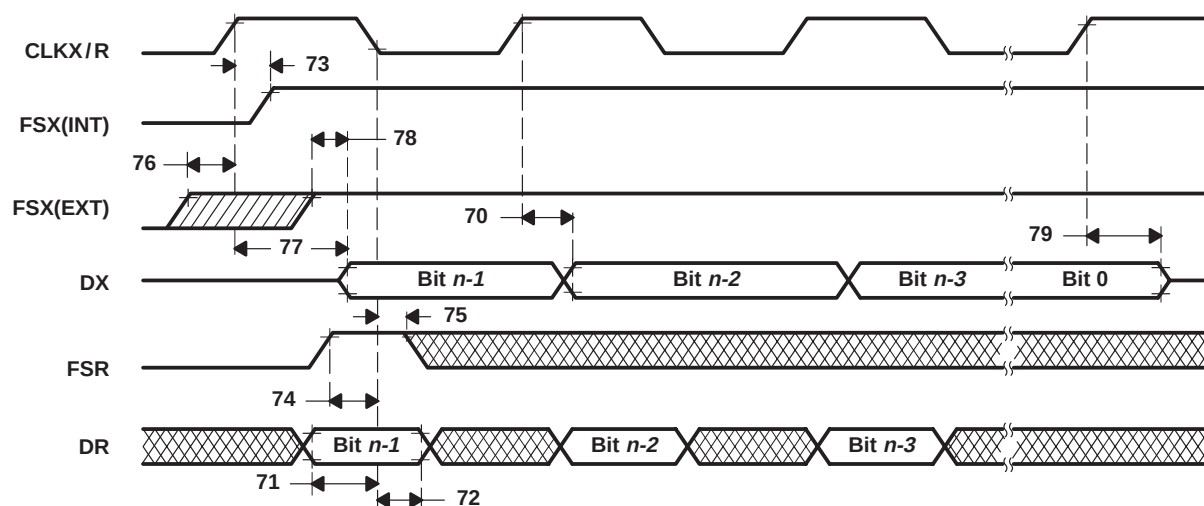
<sup>†</sup> Assured from characterization but not tested

**serial-port timing [P =  $t_{C(H)}$ ] (see Figure 29 and Figure 30) (continued)**



- NOTES: A. Timing diagrams show operations with CLKXP = CLKRP = FSXP = FSRP = 0.  
B. Timing diagrams depend upon the length of the serial-port word, where  $n = 8, 16, 24$ , or  $32$  bits, respectively.

**Figure 29. Fixed Data-Rate-Mode Timing**



- NOTES: A. Timing diagrams show operation with CLKXP = CLKRP = FSXP = FSRP = 0.  
B. Timing diagrams depend upon the length of the serial-port word, where  $n = 8, 16, 24$ , or  $32$  bits, respectively.  
C. The timings that are not specified expressly for the variable data-rate mode are the same as those that are specified for the fixed data-rate mode.

**Figure 30. Variable Data-Rate-Mode Timing**

**timing for  $\overline{\text{HOLD}}/\overline{\text{HOLDA}}$  [ $P = t_{c(H)}$ ] (see Note 6 and Figure 31)**

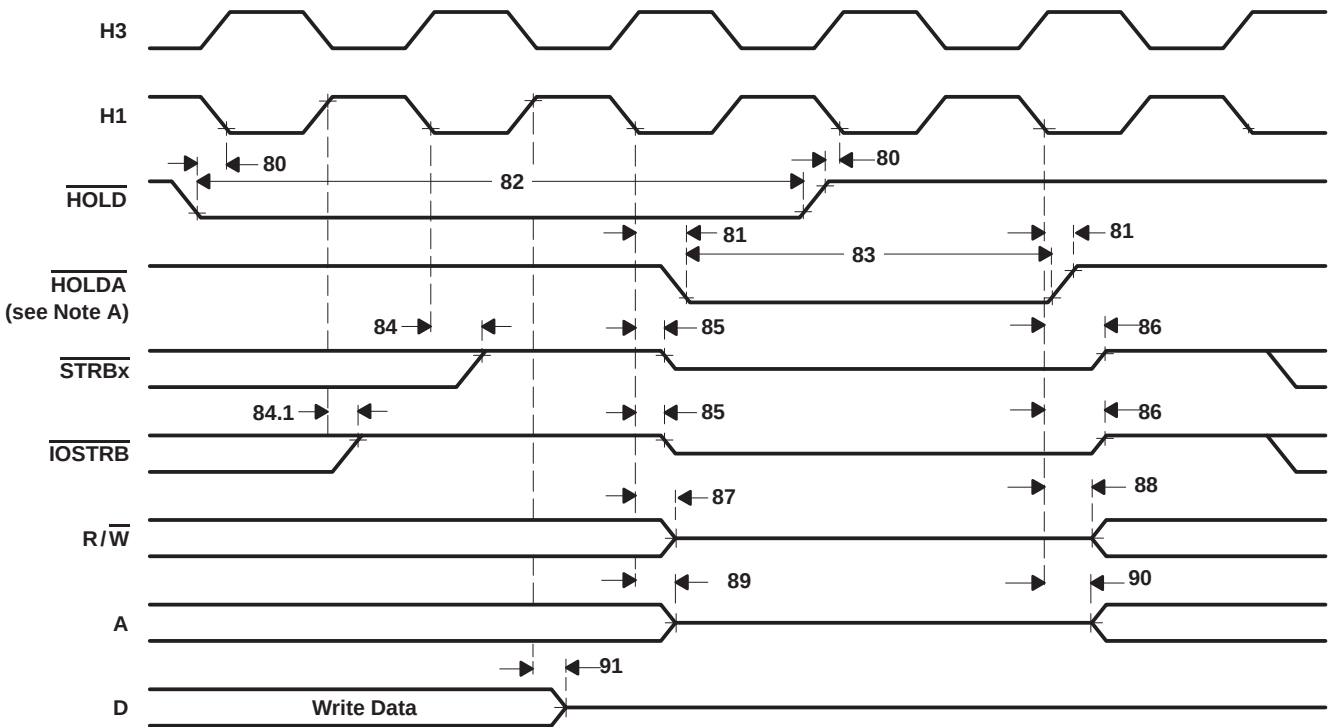
| NO.  |                                                                                               | 'C32-40          |                 | 'C32-50          |                | 'C32-60          |                | UNIT |
|------|-----------------------------------------------------------------------------------------------|------------------|-----------------|------------------|----------------|------------------|----------------|------|
|      |                                                                                               | MIN              | MAX             | MIN              | MAX            | MIN              | MAX            |      |
| 80   | $t_{su}(\text{HOLD})$ Setup time, $\overline{\text{HOLD}}$ before H1 low                      | 13               |                 | 10               |                | 8                |                | ns   |
| 81   | $t_v(\text{HOLDA})$ Valid time, $\overline{\text{HOLDA}}$ after H1 low                        | 0 <sup>†</sup>   | 9               | 0 <sup>†</sup>   | 7              | 0 <sup>†</sup>   | 6              | ns   |
| 82   | $t_w(\text{HOLD})$ Pulse duration, $\overline{\text{HOLD}}$ low                               | 2P               |                 | 2P               |                | 2P               |                | ns   |
| 83   | $t_w(\text{HOLDA})$ Pulse duration, $\overline{\text{HOLDA}}$ low                             | P–5 <sup>†</sup> |                 | P–5 <sup>†</sup> |                | P–5 <sup>†</sup> |                | ns   |
| 84   | $t_d(\text{H1L-SH})H$ Delay time, H1 low to STRBx high for a $\overline{\text{HOLD}}$         | 0 <sup>‡</sup>   | 9               | 0 <sup>‡</sup>   | 7              | 0 <sup>‡</sup>   | 6              | ns   |
| 84.1 | $t_d(\text{H1H-IO})H$ Delay time, H1 high to IOSTRB high for a $\overline{\text{HOLD}}$       | 0 <sup>‡</sup>   | 9               | 0 <sup>‡</sup>   | 7              | 0 <sup>‡</sup>   | 6              | ns   |
| 85   | $t_{dis}(\text{H1L-S})$ Disable time, H1 low to STRBx or IOSTRB (in the high-impedance state) | 0 <sup>‡</sup>   | 9 <sup>†</sup>  | 0 <sup>‡</sup>   | 8 <sup>†</sup> | 0 <sup>‡</sup>   | 7 <sup>†</sup> | ns   |
| 86   | $t_{en}(\text{H1L-S})$ Enable time, H1 low to STRBx or IOSTRB active                          | 0 <sup>‡</sup>   | 9               | 0 <sup>‡</sup>   | 7              | 0 <sup>‡</sup>   | 6              | ns   |
| 87   | $t_{dis}(\text{H1L-RW})$ Disable time, H1 low to R/W in the high-impedance state              | 0 <sup>†</sup>   | 9 <sup>†</sup>  | 0 <sup>†</sup>   | 8 <sup>†</sup> | 0 <sup>†</sup>   | 7 <sup>†</sup> | ns   |
| 88   | $t_{en}(\text{H1L-RW})$ Enable time, H1 low to R/W (active)                                   | 0 <sup>†</sup>   | 9               | 0 <sup>†</sup>   | 7              | 0 <sup>†</sup>   | 6              | ns   |
| 89   | $t_{dis}(\text{H1L-A})$ Disable time, H1 low to A in the high-impedance state                 | 0 <sup>‡</sup>   | 10 <sup>†</sup> | 0 <sup>‡</sup>   | 8 <sup>†</sup> | 0 <sup>‡</sup>   | 7 <sup>†</sup> | ns   |
| 90   | $t_{en}(\text{H1L-A})$ Enable time, H1 low to A valid                                         | 0 <sup>‡</sup>   | 13              | 0 <sup>‡</sup>   | 12             | 0 <sup>‡</sup>   | 11             | ns   |
| 91   | $t_{dis}(\text{H1H-D})$ Disable time, H1 high to D disabled in the high-impedance state       | 0 <sup>‡</sup>   | 9 <sup>†</sup>  | 0 <sup>‡</sup>   | 8 <sup>†</sup> | 0 <sup>‡</sup>   | 7 <sup>†</sup> | ns   |

<sup>†</sup> Assured from characterization but not tested

<sup>‡</sup> Not tested

NOTE 6:  $\overline{\text{HOLD}}$  is an asynchronous input and can be asserted at any point during a clock cycle. If the specified timings are met, the exact sequence shown occurs; otherwise, an additional delay of one clock cycle can occur. The NOHOLD bit of the primary-bit-control register overwrites the  $\overline{\text{HOLD}}$  signal.

timing for  $\overline{\text{HOLD}}/\overline{\text{HOLDA}}$  [ $P = t_{c(H)}$ ] (see Note 6 and Figure 31) (continued)

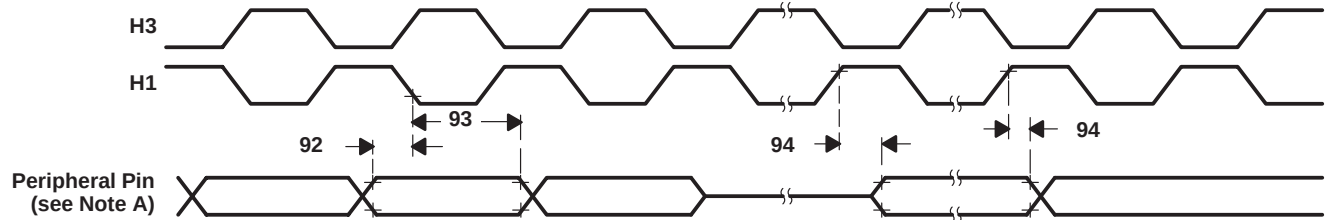


NOTE A:  $\overline{\text{HOLDA}}$  goes low in response to  $\overline{\text{HOLD}}$  going low and continues to remain low until one H1 cycle after  $\overline{\text{HOLD}}$  goes back high.

Figure 31.  $\overline{\text{HOLD}}/\overline{\text{HOLDA}}$  Timing

### timing of peripheral pin configured as general-purpose I/O (see Figure 32)

| NO. |                                                                   | 'C32-40 |     | 'C32-50 |     | 'C32-60 |     | UNIT |
|-----|-------------------------------------------------------------------|---------|-----|---------|-----|---------|-----|------|
|     |                                                                   | MIN     | MAX | MIN     | MAX | MIN     | MAX |      |
| 92  | $t_{su}(GPIOH1L)$ Setup time, general-purpose input before H1 low | 10      |     | 9       |     | 8       |     | ns   |
| 93  | $t_h(GPIOH1L)$ Hold time, general-purpose input after H1 low      | 0       |     | 0       |     | 0       |     | ns   |
| 94  | $t_d(GPIOH1H)$ Delay time, general-purpose output after H1 high   |         | 13  |         | 10  |         | 8   | ns   |

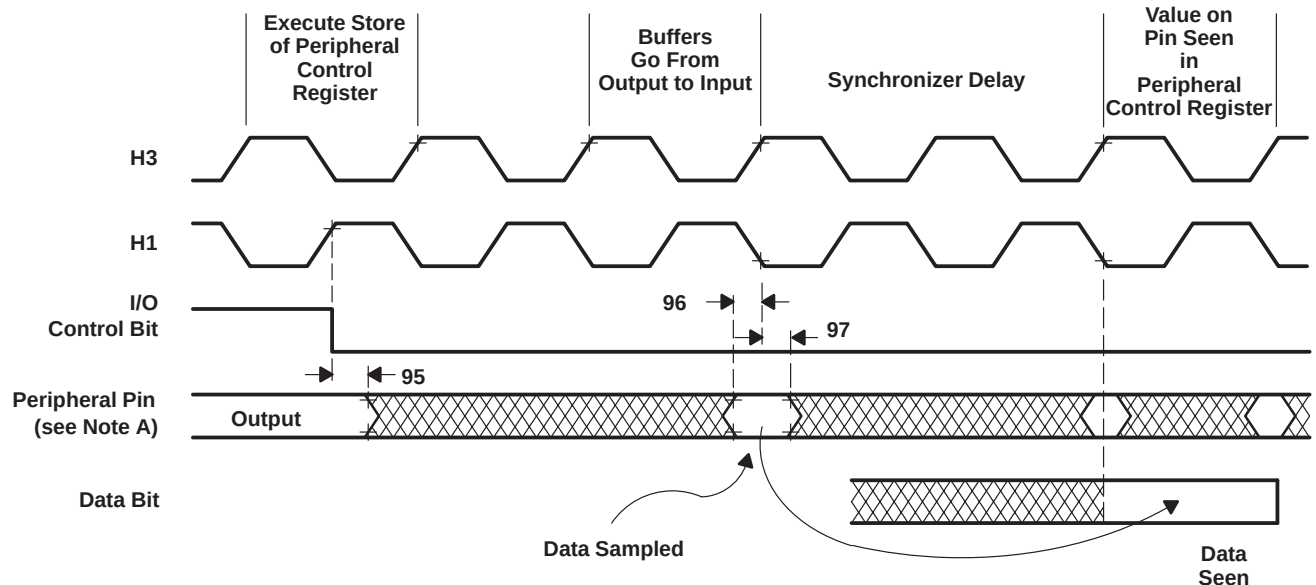


NOTE A: Peripheral pins include CLKX0, CLKR0, DX0, DR0, FSX0, FSR0, and TCLKx. The modes of these pins are defined by the contents of internal control registers associated with each peripheral.

Figure 32. Peripheral-Pin General-Purpose I/O Timing

### timing of peripheral pin changing from general-purpose output to input mode (see Figure 33)

| NO. |                                                            | 'C32-40 |     | 'C32-50 |     | 'C32-60 |     | UNIT |
|-----|------------------------------------------------------------|---------|-----|---------|-----|---------|-----|------|
|     |                                                            | MIN     | MAX | MIN     | MAX | MIN     | MAX |      |
| 95  | $t_h(H1H)$ Hold time, after H1 high                        |         | 13  |         | 12  |         | 11  | ns   |
| 96  | $t_{su}(GPIOH1L)$ Setup time, peripheral pin before H1 low | 10      |     | 9       |     | 8       |     | ns   |
| 97  | $t_h(GPIOH1L)$ Hold time, peripheral pin after H1 low      | 0       |     | 0       |     | 0       |     | ns   |

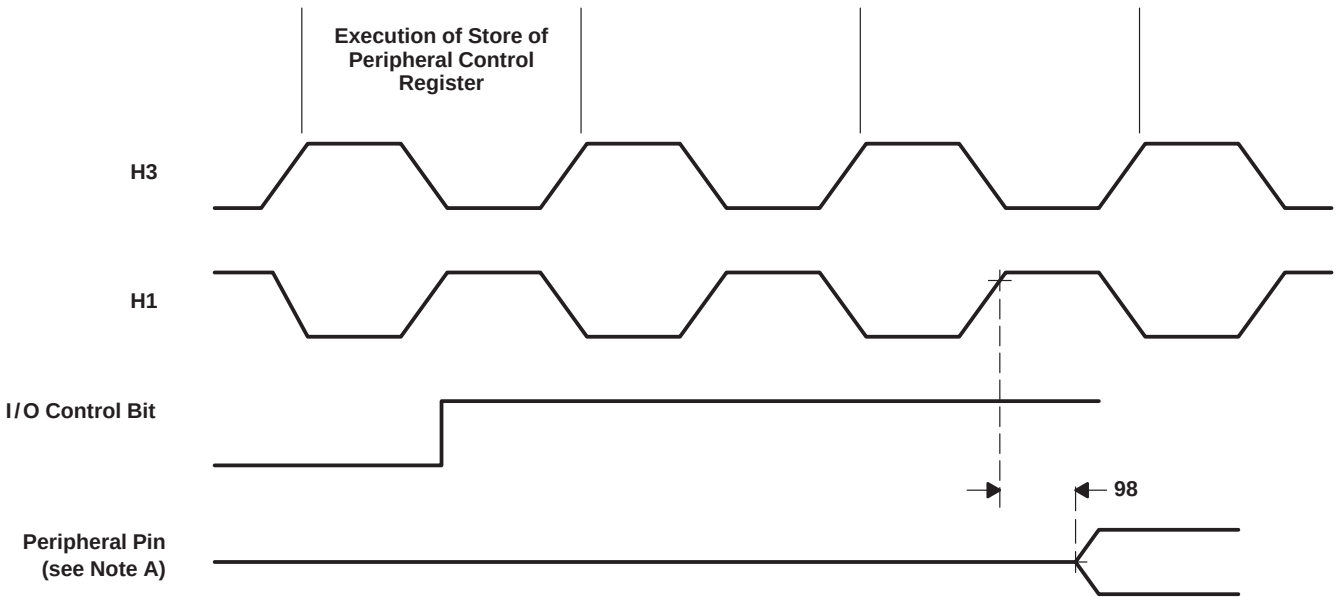


NOTE A: Peripheral pins include CLKX0, CLKR0, DX0, DR0, FSX0, FSR0, and TCLKx. The modes of these pins are defined by the contents of internal control registers associated with each peripheral.

Figure 33. Timing of Peripheral Pin Changing From General-Purpose Output to Input-Mode

timing of peripheral pin changing from general-purpose input to output mode (see Figure 34)

| NO. |                                                                                            | 'C32 - 40 |     | 'C32 - 50 |     | 'C32 - 60 |     | UNIT |
|-----|--------------------------------------------------------------------------------------------|-----------|-----|-----------|-----|-----------|-----|------|
|     |                                                                                            | MIN       | MAX | MIN       | MAX | MIN       | MAX |      |
| 98  | $t_d(\text{GPIOH1H})$ Delay time, H1 high to peripheral pin switching from input to output |           | 13  |           | 10  |           | 8   | ns   |



NOTE A: Peripheral pins include CLKX0, CLKR0, DX0, DR0, FSX0, FSR0, and TCLKx. The modes of these pins are defined by the contents of internal control registers associated with each peripheral.

Figure 34. Timing of Peripheral Pin Changing From General-Purpose Input to Output Mode



**timing for timer pin [ $P = t_{c(H)}$ ] (see Figure 35)<sup>†</sup>**

| NO. |                   |                                            | 'C32-40       |                                     | UNIT |
|-----|-------------------|--------------------------------------------|---------------|-------------------------------------|------|
|     |                   |                                            | MIN           | MAX                                 |      |
| 99  | $t_{su}(TCLKH1L)$ | Setup time, TCLK external before H1 low    | 10            |                                     | ns   |
| 100 | $t_h(TCLKH1L)$    | Hold time, TCLK external after H1 low      | 0             |                                     | ns   |
| 101 | $t_d(TCLKH1H)$    | Delay time, H1 high to TCLK internal valid |               | 9                                   | ns   |
| 102 | $t_c(TCLK)$       | Cycle time, TCLK                           | TCLK external | 2.6P                                | ns   |
|     |                   |                                            | TCLK internal | 2P (2 <sup>32</sup> )P <sup>‡</sup> |      |
| 103 | $t_w(TCLK)$       | Pulse duration, TCLK high/low              | TCLK external | P + 10                              | ns   |
|     |                   |                                            | TCLK internal | $[t_c(TCLK)/2]-5$ $[t_c(TCLK)/2]+5$ |      |

<sup>†</sup> Timing parameters 99 and 100 are applicable for a synchronous input clock. Timing parameters 102 and 103 are applicable for an asynchronous input clock.

<sup>‡</sup> Assured by design but not tested

| NO. |                   |                                            | 'C32-50       |                                     | UNIT |
|-----|-------------------|--------------------------------------------|---------------|-------------------------------------|------|
|     |                   |                                            | MIN           | MAX                                 |      |
| 99  | $t_{su}(TCLKH1L)$ | Setup time, TCLK external before H1 low    | 8             |                                     | ns   |
| 100 | $t_h(TCLKH1L)$    | Hold time, TCLK external after H1 low      | 0             |                                     | ns   |
| 101 | $t_d(TCLKH1H)$    | Delay time, H1 high to TCLK internal valid |               | 9                                   | ns   |
| 102 | $t_c(TCLK)$       | Cycle time, TCLK cycle time                | TCLK external | 2.6P                                | ns   |
|     |                   |                                            | TCLK internal | 2P (2 <sup>32</sup> )P <sup>‡</sup> |      |
| 103 | $t_w(TCLK)$       | Pulse duration, TCLK high / low            | TCLK external | P + 10                              | ns   |
|     |                   |                                            | TCLK internal | $[t_c(TCLK)/2]-5$ $[t_c(TCLK)/2]+5$ |      |

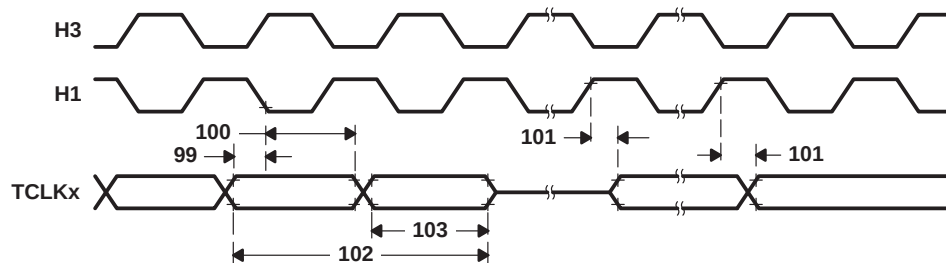
<sup>†</sup> Timing parameters 99 and 100 are applicable for a synchronous input clock. Timing parameters 102 and 103 are applicable for an asynchronous input clock.

<sup>‡</sup> Assured by design but not tested

| NO. |                   |                                            | 'C32-60       |                                     | UNIT |
|-----|-------------------|--------------------------------------------|---------------|-------------------------------------|------|
|     |                   |                                            | MIN           | MAX                                 |      |
| 99  | $t_{su}(TCLKH1L)$ | Setup time, TCLK external before H1 low    | 6             |                                     | ns   |
| 100 | $t_h(TCLKH1L)$    | Hold time, TCLK external after H1 low      | 0             |                                     | ns   |
| 101 | $t_d(TCLKH1H)$    | Delay time, H1 high to TCLK internal valid |               | 8                                   | ns   |
| 102 | $t_c(TCLK)$       | Cycle time, TCLK cycle time                | TCLK external | 2.6P                                | ns   |
|     |                   |                                            | TCLK internal | 2P (2 <sup>32</sup> )P <sup>‡</sup> |      |
| 103 | $t_w(TCLK)$       | Pulse duration, TCLK high/low              | TCLK external | P + 10                              | ns   |
|     |                   |                                            | TCLK internal | $[t_c(TCLK)/2]-5$ $[t_c(TCLK)/2]+5$ |      |

<sup>†</sup> Timing parameters 99 and 100 are applicable for a synchronous input clock. Timing parameters 102 and 103 are applicable for an asynchronous input clock.

<sup>‡</sup> Assured by design but not tested



**Figure 35. Timing for Timer Pin**

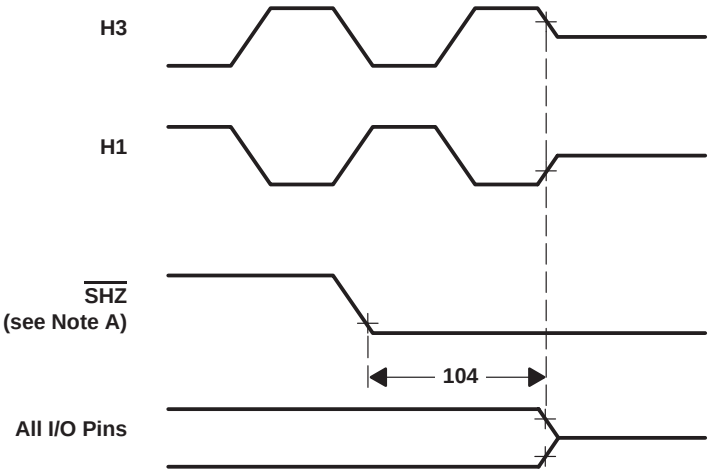
TMS320C32  
DIGITAL SIGNAL PROCESSOR

SPRS027C – JANUARY 1995 – REVISED DECEMBER 1996

timing for  $\overline{\text{SHZ}}$  pin [ $Q = t_{\text{C}}(\text{CI})$ ] (see Figure 36)

| NO. |                                                                                                                                  | 'C32-50 <sup>†</sup> |                 | 'C32-60        |                 | UNIT |
|-----|----------------------------------------------------------------------------------------------------------------------------------|----------------------|-----------------|----------------|-----------------|------|
|     |                                                                                                                                  | MIN                  | MAX             | MIN            | MAX             |      |
| 104 | $t_{\text{dis}}(\overline{\text{SHZ}})$ Disable time, $\overline{\text{SHZ}}$ low to all O, I/O pins in the high-impedance state | 0 <sup>†</sup>       | 2Q <sup>†</sup> | 0 <sup>†</sup> | 2Q <sup>†</sup> | ns   |

<sup>†</sup> Assured by characterization but not tested



NOTE A: Enabling  $\overline{\text{SHZ}}$  destroys 'C32 register and memory contents. Assert  $\overline{\text{SHZ}} = 1$  and reset the 'C32 to restore it to a known condition.

Figure 36.  $\overline{\text{SHZ}}$  Pin Timing

Table 1. Thermal Resistance Characteristics for PCM package

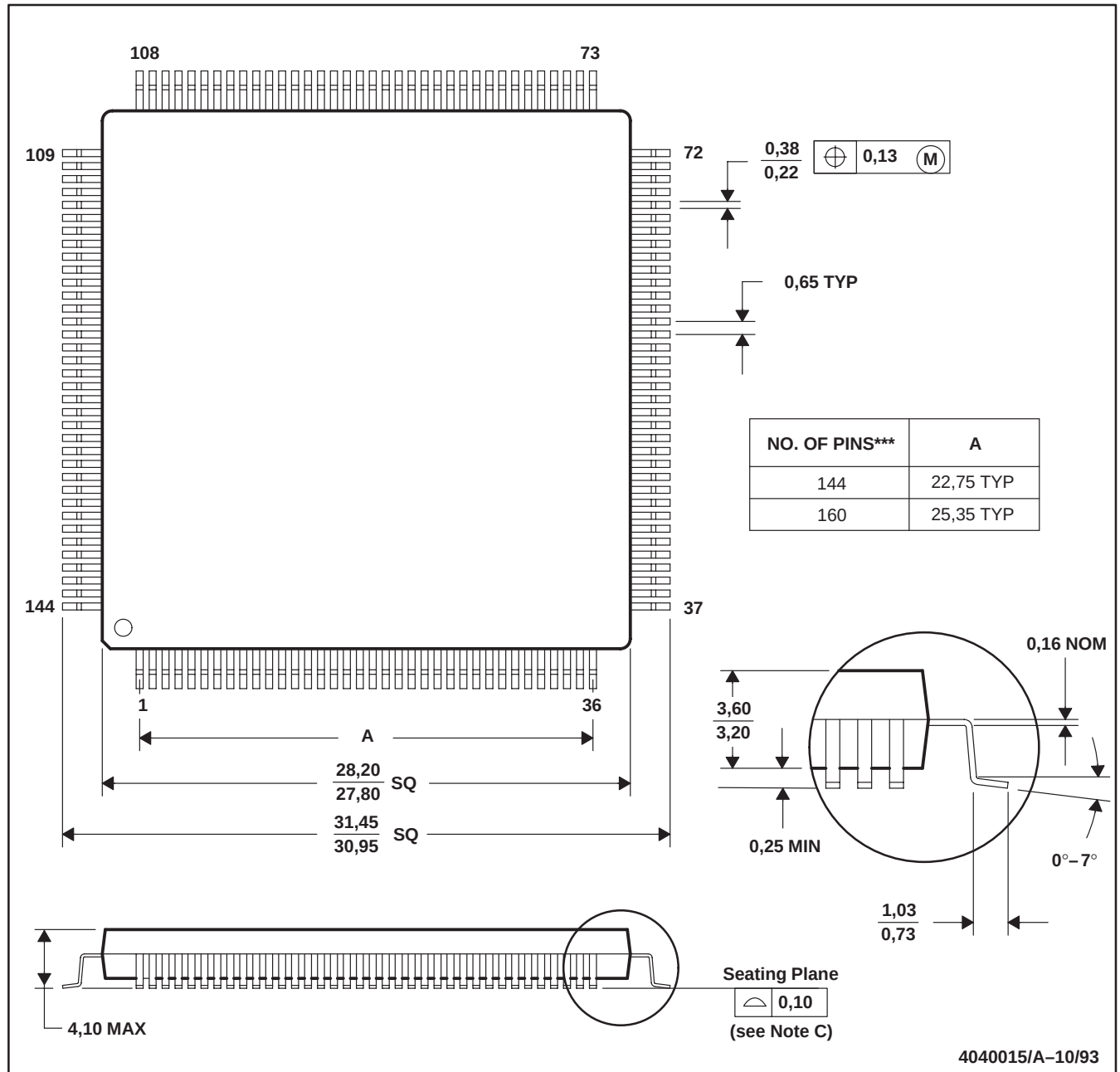
| PARAMETER             |                      | MIN | MAX  | UNIT |
|-----------------------|----------------------|-----|------|------|
| $R_{\Theta\text{JA}}$ | Junction-to-free-air |     | 39   | °C/W |
| $R_{\Theta\text{JC}}$ | Junction-to-case     |     | 10.0 | °C/W |

# MECHANICAL DATA

PCM(S-PQFP-G\*\*\*)

PLASTIC QUAD FLATPACK

144 PIN SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
B. This drawing is subject to change without notice.  
C. Falls within JEDEC MS-022  
D. The 144PCM is identical to 160PCM except that 4 leads per corner are removed.  
E. Foot length is measured from lead tip to a position on backside of lead 0,25 mm above seating plane (gage plane)  
F. Preliminary drawing

## PACKAGING INFORMATION

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| TMS320C32PCM40   | NRND                  | QFP          | PCM             | 144  | 24          | Pb-Free (RoHS)          | CU NIPDAU        | Level-4-245C-72HR            |
| TMS320C32PCM50   | NRND                  | QFP          | PCM             | 144  | 24          | Pb-Free (RoHS)          | CU NIPDAU        | Level-4-245C-72HR            |
| TMS320C32PCM60   | NRND                  | QFP          | PCM             | 144  | 24          | Pb-Free (RoHS)          | CU NIPDAU        | Level-4-245C-72HR            |
| TMS320C32PCMA40  | NRND                  | QFP          | PCM             | 144  | 24          | Pb-Free (RoHS)          | CU NIPDAU        | Level-4-245C-72HR            |
| TMS320C32PCMA50  | NRND                  | QFP          | PCM             | 144  | 24          | Pb-Free (RoHS)          | CU NIPDAU        | Level-4-245C-72HR            |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

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